



Lenovo ThinkSystem SR860 V2 Server

The Lenovo ThinkSystem SR860 V2 is a 4-socket server that features a 4U rack design with support for high-performance GPUs. The server offers technology advances, including third-generation Intel Xeon Scalable processors with Intel Optane Persistent Memory 200 Series, and scale-up capacity with up to 12TB of system memory, up to 14x PCIe slots, and up to 48x 2.5-inch drive bays.

Suggested uses: Mission critical workloads such as SAP HANA in-memory computing, transactional databases, deep learning, analytics, big data, and virtual machine density.



Figure 1. Lenovo ThinkSystem SR860 V2

Did you know?

The Lenovo ThinkSystem SR860 V2 provides the advanced capabilities of four of the new third-generation Intel Xeon Scalable processors plus support for four double-wide GPUs such as the NVIDIA Tesla V100S GPU. This combination gives you significant processing power in one server.

The SR860 V2 has space for 48x 2.5-inch drive bays, 24 of which can be configured as AnyBay drives - supporting SAS, SATA or NVMe drives. NVMe drives are high-speed, low-latency storage, ideal for storage tiering.

Key features

The flexible ThinkSystem SR860 V2 server supports third-generation Intel Xeon Scalable Gold or Platinum processors and can scale from two to four processors. Built for standard workloads like general business applications and server consolidation, it can also accommodate high-growth areas such as databases and virtualization. The ThinkSystem SR860 V2's agile design permits rapid upgrades for processors and memory, and its large, flexible storage capacity helps to keep pace with data growth.

With the capability to support up to 48 DIMMs, four sockets, up to 48 drives for internal storage, support for up to eight high-performance NVIDIA Tesla T4 GPUs or four NVIDIA V100S GPUs, and a dedicated OCP 3.0 slot for 1, 10 or 25 GbE networking, the SR860 V2 provides unmatched features and capabilities in a 4U rack-mount design.

Scalability and performance

The SR860 V2 offers numerous features to boost performance, improve scalability and reduce costs:

- Supports two or four 3rd Gen Intel Xeon Processor Scalable processors, allowing you to start with two
 processors and then upgrade to four when you need it.
- Supports Gold and Platinum level H and HL processors in the Intel Xeon Processor Scalable Family.
 Processors supported have up to 28 cores, core speeds of up to 3.9 GHz, and TDP ratings of up to 250W.
- The SR860 V2's processor expansion tray design enables you to start with two processors and 24 DIMM sockets and upgrade to four processors and 48 DIMM sockets when you need it, helping lower initial costs and manage growth.
- Up to four processors, 112 cores, and 224 threads maximize the concurrent execution of multithreaded applications.
- Enhanced inter-processor communications with six UPI connections between adjacent processors ensures increased CPU I/O throughput.
- Supports the new bfloat16 instruction set for Enhanced Deep Learning Boost
- Intelligent and adaptive system performance with Intel Turbo Boost Technology 2.0 allows processor cores to run at maximum speeds during peak workloads by temporarily going beyond processor TDP.
- Intel Hyper-Threading Technology boosts performance for multithreaded applications by enabling simultaneous multithreading within each processor core, up to two threads per core.
- Intel Virtualization Technology integrates hardware-level virtualization hooks that allow operating system vendors to better use the hardware for virtualization workloads.
- Intel Speed Select Technology supported on some processor models, enables increased core Turbo Boost frequency on specific individual cores to maximize application performance.
- Enhanced Intel Deep Learning Boost provides built-in acceleration with the Vector Neural Network Instruction set (VNNI) and new bloat16 instructions. These are designed to deliver significant, more efficient Deep Learning (Inference) acceleration for high-performance Artificial Intelligence (AI) workloads.
- Intel Advanced Vector Extensions 512 (AVX-512) enable acceleration of enterprise-class workloads, including databases and enterprise resource planning (ERP).
- Support for up to 48 TruDDR4 memory DIMMs operating at up to 3200 MHz means you have the fastest available memory subsystem and memory capacity of up to 12 TB with 48x 256 GB 3DS RDIMMs.
- Supports configurations of 2 DIMMs per channel to operate at the 3200 MHz rated speed of the memory DIMMs.
- Supports the new Intel Optane Persistent Memory 200 Series for advanced in-memory database applications, dense-virtualization; up to 24 PMem Modules can be installed in conjunction with regular system memory. PMem modules are up to 512 GB each, for a total of up to 12 TB of Persistent Memory (3 TB per processor).

- The use of solid-state drives (SSDs) instead of, or along with, traditional spinning drives (HDDs), can improve I/O performance. An SSD can support up to 100 times more I/O operations per second (IOPS) than a typical HDD.
- Up to 48x 2.5-inch drive bays -- supporting combinations of SAS or SATA HDDs, SAS or SATA SSDs, and NVMe PCle SSDs -- provide a flexible and scalable all-in-one platform to meet your increasing demands. Up to 24x NVMe drives are supported, maximizing drive I/O performance in terms of throughput, bandwidth, and latency.
- The server has a dedicated industry-standard OCP 3.0 small form factor (SFF) slot, with a PCle 3.0 x16 interface, supporting a variety of Ethernet network adapters. Simple-swap mechanism with thumbscrews and pull-tab enables tool-less installation and removal of the adapter. Supports shared BMC network sideband connectivity to enable out-of-band systems management.
- Up to 14 PCIe 3.0 slots in addition to the OCP 3.0 Ethernet slot to maximize I/O capabilities.
- New high-speed RAID controllers from Broadcom provide 12 Gb SAS connectivity to the drive backplanes. A variety of RAID adapters are available, with cache up to 8 GB and support for 32 drives on a single controller. The RAID 940-16i 8GB Flash adapter supports RAID volumes with NVMe, SAS or SATA drives.
- Support for four high-performance double-wide GPUs such as the NVIDIA Tesla V100S, or eight single-wide GPUs such as the NVIDIA T4 GPU. GPUs adds additional processing power to the server.
- Supports up to two externally accessible 7mm hot-swap drives with RAID functionality, in addition to the 48 front drive bays. These 7mm drives are ideal for operating system boot functions.
- As an alternative to the 7mm drives, the server supports the Lenovo patented-design M.2 adapter for convenient operating system boot functions. Available M.2 adapters support either one M.2 drive or two M.2 drives in a RAID 1 configuration for boot drive performance and reliability.
- Integrated SATA controller with Software RAID (Intel RSTe) support for up to 8x drives with basic RAID functionality with no additional adapter needed.
- Supports Intel VROC (Virtual RAID on CPU) which enables basic RAID functionality on the onboard NVMe ports of the server, with no additional adapter needed. This feature enables RAID on NVMe drives without the need for a separate RAID adapter.

Availability and serviceability

The SR860 V2 provides many features to simplify serviceability and increase system uptime:

- The server offers Single Device Data Correction (SDDC, also known as Chipkill), Adaptive Double-Device Data Correction (ADDDC, also known as Redundant Bit Steering or RBS), memory mirroring, and memory rank sparing for redundancy in the event of a non-correctable memory failure.
- The server offers hot-swap drives, supporting RAID redundancy for data protection and greater system uptime.
- Available M.2 RAID Boot Adapter supports RAID-1 which can enable two SATA M.2 drives to be configured as a redundant pair.
- Available pair of 7mm hot-swap drives support RAID-1 which can enable two SATA or two NVMe drive to be configured as a redundant pair.
- The server has up to four hot-swap redundant power supplies and eight N+1 redundant fans to provide availability for business-critical applications.
- The power-source-independent light path diagnostics uses LEDs to lead the technician to failed (or failing) components, which simplifies servicing, speeds up problem resolution, and helps improve system availability.
- An integrated diagnostics panel with LCD display (optional in China, standard in other markets)
 provides more detailed diagnostics by displaying all error messages and VPD data needed for a
 service call, thereby aiding with problem resolution and system uptime.

- Proactive Platform Alerts (including PFA and SMART alerts): Processors, voltage regulators, memory, internal storage (SAS/SATA HDDs and SSDs, NVMe SSDs, M.2 storage, flash storage adapters), fans, power supplies, RAID controllers, server ambient and subcomponent temperatures. Alerts can be surfaced through the XClarity Controller to managers such as Lenovo XClarity Administrator, VMware vCenter, and Microsoft System Center. These proactive alerts let you take appropriate actions in advance of possible failure, thereby increasing server uptime and application availability.
- Solid-state drives (SSDs) offer more reliability than traditional mechanical HDDs for greater uptime.
- The built-in XClarity Controller continuously monitors system parameters, triggers alerts, and performs recovery actions in case of failures, to minimize downtime.
- Built-in diagnostics in UEFI, using Lenovo XClarity Provisioning Manager, speed up troubleshooting tasks to reduce service time.
- Lenovo XClarity Provisioning Manager collects and saves service data to USB key drive or remote CIFS share folder, for troubleshooting and to reduce service time.
- Auto restart in the event of a momentary loss of AC power (based on the power policy setting in the XClarity Controller service processor)
- Support for the XClarity Administrator Mobile app running on a supported smartphone or tablet and connected to the server through the front USB 2.0 port, enables additional local systems management functions.
- Three-year or one-year customer-replaceable unit and onsite limited warranty, 9 x 5 next business day. Optional service upgrades are available.

Manageability and security

Powerful systems management features simplify local and remote management of the SR860 V2:

- Lenovo XClarity Controller (XCC) monitors server availability and performs remote management.
 XCC Enterprise is standard, which enables remote KVM, the mounting of remote media files (ISO and IMG image files), boot capture, and power capping.
- Lenovo XClarity Administrator offers comprehensive hardware management tools that help to increase uptime, reduce costs and improve productivity through advanced server management capabilities.
- UEFI-based Lenovo XClarity Provisioning Manager, accessible from F1 during boot, provides system inventory information, graphical UEFI Setup, platform update function, RAID Setup wizard, operating system installation function, and diagnostic functions.
- Support for Lenovo XClarity Energy Manager, which captures real-time power and temperature data from the server and provides automated controls to lower energy costs.
- Integrated Trusted Platform Module (TPM) 2.0 support enables advanced cryptographic methods, such as digital signatures and remote attestation.
- Supports Secure Boot to ensure only a digitally signed operating system can be used. Supported with HDDs and SSDs, as well as 7mm and M.2 drives.
- Industry-standard Advanced Encryption Standard (AES) NI support for faster, stronger encryption.
- Intel Execute Disable Bit functionality can prevent certain classes of malicious buffer overflow attacks when combined with a supported operating system.
- Intel Trusted Execution Technology provides enhanced security through hardware-based resistance
 to malicious software attacks, allowing an application to run in its own isolated space, protected from
 all other software running on a system.

Energy efficiency

The SR860 V2 offers the following energy-efficiency features to save energy, reduce operational costs, and increase energy availability:

- Energy-efficient planar components help lower operational costs.
- High-efficiency power supplies with 80 PLUS Platinum and Titanium certifications
- Intel Intelligent Power Capability turns individual processor elements on and off as needed to reduce power draw.
- Low-voltage 1.2 V DDR4 memory offers energy savings compared to 1.35 V and 1.5 V DDR3 DIMMs.
- Solid-state drives (SSDs) consume as much as 80% less power than traditional spinning 2.5-inch HDDs.
- The server uses hexagonal ventilation holes, which can be grouped more densely than round holes, providing more efficient airflow through the system and thus keeping your system cooler.
- Optional Lenovo XClarity Energy Manager provides advanced data center power notification, analysis, and policy-based management to help achieve lower heat output and reduced cooling needs.

Components and connectors

The following figure shows the front of the server.

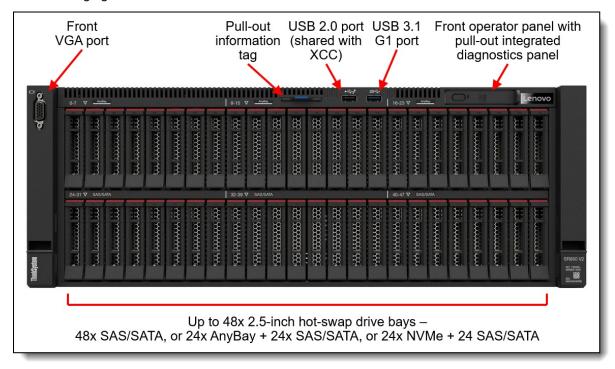


Figure 2. Front view of the ThinkSystem SR860 V2

The following figure shows the rear of the server.

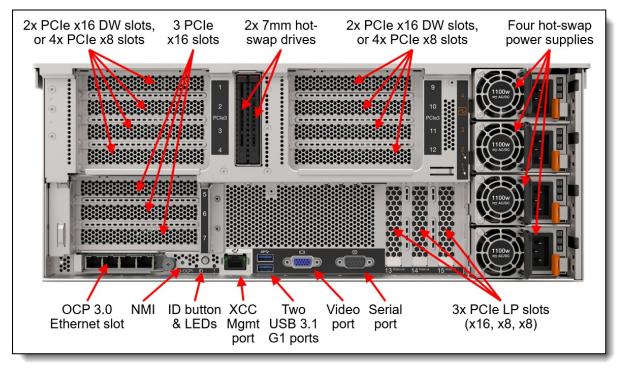


Figure 3. Rear view of the ThinkSystem SR860 V2

The following figure shows the locations of key components inside the server with the GPU trays and the processor and memory expansion tray removed.

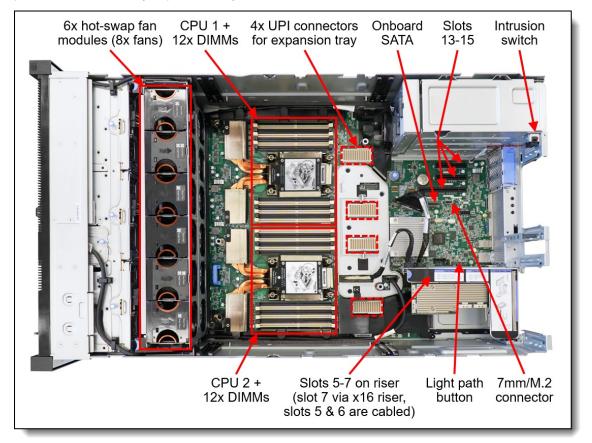


Figure 4. Internal view (GPU trays and the processor and memory expansion tray removed)

The following figure shows the inside the server with processor and memory expansion tray installed.

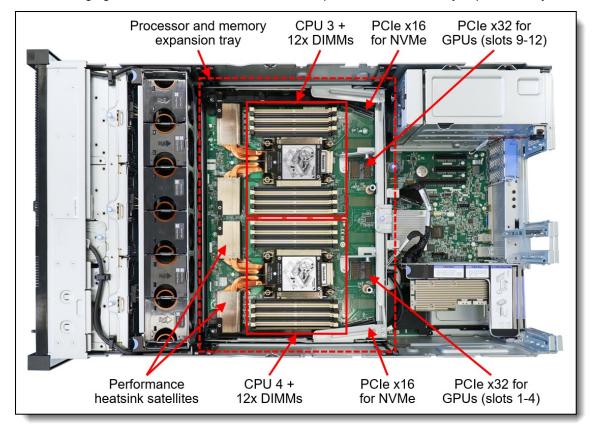


Figure 5. Internal view (processor and memory expansion tray installed)

The upper 2U of the server is where the GPU adapters are installed. The following figure shows the inside the server with GPU tray and upper riser slots installed.

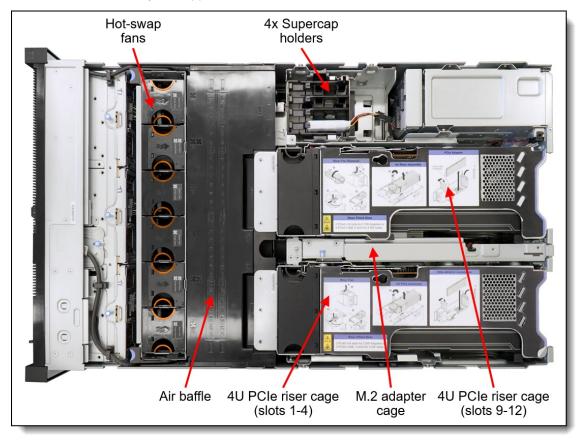


Figure 6. Internal view (GPU tray and riser slots installed)

System architecture

The following figure shows the architectural block diagram of the SR860 V2, showing the major components and their connections.

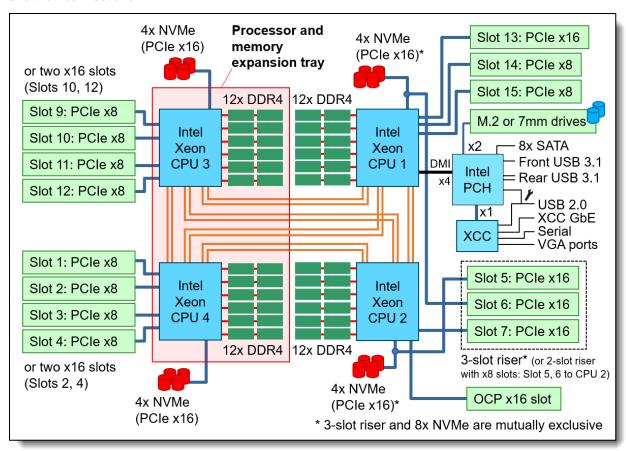


Figure 7. SR860 V2 system architectural block diagram

Standard specifications

The following table lists the standard specifications.

Table 1. Standard specifications

Components	Specification
Machine types	7Z59 - 1-year warranty 7Z60 - 3-year warranty 7D42 - SAP HANA configurations with 3-year warranty
Form factor	4U rack.
Processor	Two or four third-generation Intel Xeon Scalable processors, either Gold or Platinum level processors, with H or HL suffixes (formerly codename "Cooper Lake" or CPX6). Supports processors up to 28 cores, core speeds up to 3.9 GHz, and TDP ratings up to 250W. Two processor sockets on the system board and two processors on the Processor and Memory Expansion Tray. Six Intel Ultra Path Interconnect (UPI) links at 10.4 GT/s each. Four processors are connected in a mesh topology.
Chipset	Intel C621A "Lewisburg" chipset, part of the platform codenamed "Cedar Island" (CDS)

Components	Specification
Memory	Up to 48 DIMM slots (12 DIMMs per processor). Each processor has 6 memory channels, with 2 DIMMs per channel. Lenovo TruDDR4 RDIMMs and 3DS RDIMMs are supported. 24 DIMM sockets on the system board, and an additional 24 DIMM sockets on the processor and memory expansion tray. DIMM slots are shared between standard system memory and persistent memory. DIMMs operate at up to 3200 MHz at 2 DPC.
Persistent memory	Supports up to 24x Intel Optane Persistent Memory 200 Series modules installed in the DIMM slots. Persistent memory is installed in combination with system memory DIMMs. Supports App Direct mode to enhance the performance of applications such as SAP HANA.
Memory maximums	 With system memory DIMMs: Up to 12TB with 48x 256GB 3DS RDIMMs and four processors (3.0TB per processor).
	 With Persistent Memory in AppDirect mode: Up to 18TB total memory (12TB of Persistent Memory using 24x 512GB PMMs + 6TB of system memory using 24x 256GB 3DS RDIMMs and four processors) (4.5TB per processor)
	Note : Support of more than 1.125TB per processor (more than 4.5TB total for a 4-processor system) requires HL-suffix processors. These calculations include any Persistent Memory installed. See the Memory capacity of processors section for more information.
Memory protection	ECC, SDDC (for x4-based memory DIMMs), ADDDC (for x4-based memory DIMMs), memory mirroring, and memory sparing.
Disk drive bays	Up to 48x 2.5-inch hot-swap drive bays: • Up to 48x SAS/SATA drive bays • Up to 24x SAS/SATA + 24x NVMe drive bays • Up to 24x SAS/SATA + 24x AnyBay drive bays (support SAS or SATA or NVMe drives)
	Optional two 7mm hot-swap SSD drive bays at the rear of the server, either SATA or NVMe, for OS boot or storage
Maximum internal storage	 737.28TB using 48x 15.36TB 2.5-inch SAS SSDs 192TB using 24x 8TB 2.5-inch NVMe SSDs 115.2TB using 48x 2.4TB 2.5-inch HDDs
	Mix of NVMe/SSDs/HDDs supported.
Storage	8x Onboard SATA ports (Intel VROC SATA RAID, formerly known as Intel RSTe RAID)
controller	 Up to 16x Onboard NVMe ports (includes Intel VROC NVMe RAID, with optional license for non-Intel NVMe SSDs)
	NVMe Switch Adapters (no RAID) (also supports Intel VROC)
	 12 Gb SAS/SATA RAID adapters: RAID 530i-8i (cacheless) supports RAID 0, 1, 10, 5, 50 RAID 530i-16i (cacheless) supports RAID 0, 1, 10 RAID 930-8i with 2GB flash-backed cache supports RAID 0, 1, 10, 5, 50, 6, 60 RAID 930-16i with 4GB flash-backed cache supports RAID 0, 1, 10, 5, 50, 6, 60 RAID 940-32i with 8GB flash-backed cache supports RAID 0, 1, 10, 5, 50, 6, 60
	• 12 Gb SAS/SATA non-RAID: 430-8i and 430-16i HBAs
Optical drive bays	No internal optical drive.
Tape drive bays	No internal backup drive.

Components	Specification
Network interfaces	Dedicated OCP 3.0 SFF slot with PCle 3.0 x16 host interface. Supports a variety of 2-port and 4-port adapters with 1GbE, 10GbE and 25GbE network connectivity. One port can optionally be shared with the XClarity Controller (XCC) management processor for Wake-on-LAN and NC-SI support.
PCI Expansion slots	Up to 14 PCle 3.0 slots plus an OCP 3.0 slot reserved for an Ethernet adapter. Three slots (slots 13, 14, 15) are on the system board and three slots (slots 5, 6, 7) are through a lower riser card. Slots 1, 2, 3, 4 and slots 9, 10, 11, 12 are via upper riser cards that connect to the processors on the processor and memory expansion tray. Slots 1-4 and 9-12 require 4 processors.
	The slots are as follows:
	 Slot 1: PCle x8 FHFL (not present if slot 2 is PCle x16) (CPU 4) Slot 2: PCle x8 FHFL or PCle x16 FHFL double-wide (CPU 4) Slot 3: PCle x8 FHFL (not present if slot 4 is PCle x16) (CPU 4) Slot 4: PCle x8 FHFL or PCle x16 FHFL double-wide (CPU 4) Slot 5: PCle x16 FHHL (CPU 2) or PCle x8 FHHL with 2-slot riser (CPU 2)* Slot 6: PCle x16 FHHL (CPU 1) or PCle x8 FHHL with 2-slot riser (CPU 1)* Slot 7: PCle x16 FHHL (not present if 2-slot riser is selected) (CPU 2)* Slot 8: OCP 3.0 slot with PCle x16 connection (CPU 2) Slot 9: PCle x8 FHFL (not present if slot 10 is PCle x16) (CPU 3) Slot 10: PCle x8 FHFL or PCle x16 FHFL double-wide (CPU 3) Slot 11: PCle x8 FHFL (not present if slot 12 is PCle x16) (CPU 3) Slot 12: PCle x8 FHFL or PCle x16 FHFL double-wide (CPU 3) Slot 13: PCle x16 LP (CPU 1) Slot 14: PCle x8 LP (CPU 1) Slot 15: PCle x8 LP (CPU 1)
	* Slots 5, 6 and 7 are implemented using a riser. With a 3-slot riser, all slots are PCle x16, however this riser is mutually exclusive with 8x NVMe drive connections. Alternatively, a 2-slot riser can be selected (slots 5 & 6, both PCle x8) which allow the use of the 8x NVMe drive connections. See the System architecture section for a graphical view of the connections.
GPU support	Supports up to 8x single-wide GPUs or up to 4x double-wide GPUs
Ports	Front: One VGA video port. 1x USB 3.1 G1 (5 Gb/s) port, 1x USB 2.0 port. The USB 2.0 port can be configured to support local systems management by using the XClarity Administrator mobile app on a mobile device connected via a USB cable.
	Rear: Two USB 3.1 G1 (5 Gbp/s) ports, one VGA video port, one DB-9 serial port, and one RJ-45 XClarity Controller (XCC) systems management port. The serial port can be shared with the XCC for serial redirection functions.
	Internal: Optional M.2 adapter in dedicated slot supporting one or two M.2 drives (for OS boot support, including hypervisor support).
Cooling	Eight N+1 redundant hot-swap 60 mm fans (all eight standard). Two additional fans connected to each of the two upper riser units. One additional fan integrated in each of the four power supplies.
Power supply	Up to four hot-swap redundant AC power supplies (all 80 PLUS Platinum or Titanium certification): 750 W, 1100 W and 1800 W AC options, supporting 220 V AC. 750 W and 1100 W options also support 110V input supply. In China only, all power supply options support 240 V DC. Power supplies can be configured as N+1 or N+N.
Video	G200 graphics with 16 MB memory with 2D hardware accelerator, integrated into the XClarity Controller. Maximum resolution is 1920x1200 32bpp at 60Hz.
Hot-swap parts	Drives, fans and power supplies.

Components	Specification
Systems management	Operator panel with status LEDs and pull-out Integrated Diagnostics Panel with LCD display (pull-out panel is optional in China). Light path diagnostics for local failure detection and reporting. XClarity Controller (XCC) embedded management with remote management (via dedicated management RJ45 port) and local management (via diagnostics panel and via XClarity Mobile app on a mobile device tethered to front USB 2.0 port), XClarity Controller Enterprise enabling remote control functions, XClarity Administrator centralized infrastructure delivery, XClarity Integrator plugins, and XClarity Energy Manager centralized server power management.
Security features	Chassis intrusion switch, Power-on password, administrator's password, Trusted Platform Module (TPM), supporting TPM 2.0. In China only, optional Nationz TPM 2.0. Lockable top cover.
Operating systems supported	Microsoft Windows Server, Red Hat Enterprise Linux, SUSE Linux Enterprise Server, VMware ESXi. See the Operating system support section for specifics.
Limited warranty	Three-year or one-year (model dependent) customer-replaceable unit and onsite limited warranty with 9x5 next business day (NBD).
Service and support	Optional service upgrades are available through Lenovo Services: 4-hour or 2-hour response time, 6-hour fix time, 1-year or 2-year warranty extension, software support for Lenovo hardware and some third-party applications. Actual offering may depend on the country where the server is installed and is subject to change.
Dimensions	Width: 447 mm (17.6 in.), height: 175 mm (6.9 in.), depth: 807 mm (31.8 in.). See hysical and electrical specifications for details.
Weight	Maximum: 62 kg (137 lb)

The SR860 V2 servers are shipped with the following items:

- Documentation flyer
- Rail kit (model dependent)
- Power cords (model and region dependent)

Models

ThinkSystem SR860 V2 models can be configured by using the Lenovo Data Center Solution Configurator (DCSC).

Configure-to-order (CTO) models are used to create models with factory-integrated server customizations. For CTO models, two base CTO models are available for the SR860 V2 as listed in the following table, CTO1WW and CTOLWW:

- The CTO1WW base CTO model is for general business and is selectable by choosing **General Purpose** mode in DCSC.
- The CTOLWW base model is intended for High Performance Computing (HPC) and Artificial Intelligence (AI) configurations and solutions, including configurations for Lenovo Scalable Infrastructure (LeSI), and is enabled using either the HPC & AI LeSI Solutions mode or HPC & AI ThinkSystem Hardware mode in DCSC. CTOLWW configurations can also be built using System x and Cluster Solutions Configurator (x-config).

Preconfigured server models may also be available for the SR860 V2, however these are region-specific; that is, each region may define their own server models, and not all server models are available in every region.

The following table lists the base CTO models of the ThinkSystem SR860 V2 server.

Table 2. Base CTO models

Description	Machine Type/Model General purpose	Machine Type/Model for HPC and Al
ThinkSystem SR860 V2 - 3 year Warranty	7Z60CTO1WW	7Z60CTOLWW
ThinkSystem SR860 V2 - 1 year Warranty	7Z59CTO1WW	7Z59CTOLWW
ThinkSystem SR860 V2 - No warranty	7Y38CTO1WW	7Y38CTOLWW
ThinkSystem SR860 V2 - SAP HANA configurations with 3-year warranty	7D42CTO1WW	7D42CTOLWW

The following tables list the available models, grouped by region:

- Models for AP
- Models for EMEA

Models for the AP region

The following table lists the models for the Asia Pacific region: Australia, Bangladesh, Brunei, Hong Kong, India, Japan, Korea, Sri Lanka, Malaysia, New Zealand, Philippines, Singapore, Thailand, Taiwan, Vietnam

Table 3. SR860 V2 models for AP

Model	Intel Xeon processors†	Memory	RAID	Drive bays / max 2.5" drives; 7mm drives / max	ОСР	Slots	Power supplies	Fans‡	Rail kit‡	Intrusion‡
TopSeller mod	els with a 3-year warranty (m	achine typ	e 7Z60)							
7Z60A00JAP	2x Gold 5318H 18C 150W 2.5GHz	2x 16GB	1x 930-8i	8x SAS/SATA / 48 2.5" open bay; Optional 7mm	Open	3 / 14 (No risers)	2x 1100W	S	Υ	0
7Z60A00HAP	2x Gold 5320H 20C 150W 2.4GHz	2x 16GB	1x 930-8i	8x SAS/SATA / 48 2.5" open bay; Optional 7mm	Open	3 / 14 (No risers)	2x 1100W	S	Υ	0
7Z60A00GAP	2x Gold 6330H 24C 150W 2.0GHz	2x 16GB	1x 930-8i	8x SAS/SATA / 48 2.5" open bay; Optional 7mm	Open	3 / 14 (No risers)	2x 1100W	S	Υ	0
7Z60A00KAP	2x Platinum 8354H 18C 205W 3.1GHz	2x 16GB	1x 930-8i	8x SAS/SATA / 48 2.5" open bay; Optional 7mm	Open	3 / 14 (No risers)	2x 1800W	Р	Υ	0

[†] Processor description: Intel processor model, number of cores, thermal design power (TDP), core frequency

Models for the EMEA region

The following table lists the models for the Europe, Middle East and Africa region.

Table 4. SR860 V2 models for EMEA

Model	Intel Xeon processors†	Memory	RAID	Drive bays / max 2.5" drives; 7mm drives / max	ОСР	Slots	Power supplies	Fans‡	Rail kit‡	Intrusion‡
Standard mode	els with a 3-year warranty	(machine	type 7Z6	0)						
7Z60A00NEA	4x Gold 5318H 18C 150W 2.5GHz	4x 32GB 2Rx4	1x 940-16i	16x AnyBay / 48 2.5" open bay; 1x 7mm S4510 480GB / 2	Open	5 / 14 (Riser 1 is x8/x8)	4x 1800W	Р	Υ	Υ
7Z60A00MEA	4x Gold 6330H 24C 150W 2.0GHz	4x 32GB 2Rx4	1x 940-16i	16x AnyBay / 48 2.5" open bay; 1x 7mm S4510 480GB / 2	Open	5 / 14 (Riser 1 is x8/x8)	4x 1800W	Р	Υ	Υ
7Z60A00LEA	4x Platinum 8360H 24C 225W 3.0GHz	4x 64GB	1x 940-16i	16x AnyBay / 48 2.5" open bay; 1x 7mm S4510 480GB / 2	Open	5 / 14 (Riser 1 is x8/x8)	4x 1800W	Р	Υ	Υ

[†] Processor description: Intel processor model, number of cores, thermal design power (TDP), core frequency

[‡] Fans: S=Standard modules, P=Performance modules; Rail kit: Y=Included, O=Optional; Intrusion switch: Y=Included, O=Optional

[‡] Fans: S=Standard modules, P=Performance modules; Rail kit: Y=Included, O=Optional; Intrusion switch: Y=Included, O=Optional

Processor options

The SR860 V2 supports Gold and Platinum level processors in the third-generation Intel Xeon Scalable Processor family.

The server supports two or four processors.

- Processors 1 and 2 are installed in sockets on the system board.
- Processors 3 and 4 are installed on the Processor and Memory Expansion Tray.

The Processor and Memory Expansion Tray has a sliding and rolling lift mechanism that requires only a one-handed operation to insert or remove from the server. It has a toolless design for superior usability, serviceability and reliability.



Figure 8. SR860 V2 Processor and Memory Expansion Tray

The ordering information for the Processor and Memory Expansion Tray is shown in the following table.

Table 5. Processor and Memory Expansion Tray

Part number	Feature code	Description
4B27A09311	BAVY	ThinkSystem SR860 V2 Processor and Memory Expansion Tray

The following processor quantities are supported:

- Two processors, installed in sockets 1 and 2, without the Processor and Memory Expansion Tray
- Four processors, installed in all four sockets

Note: Configurations of one or three processors are not supported.

The table below lists the supported third-generation Intel Xeon Scalable processors.

All supported processors have the following characteristics:

Third-generation Intel Xeon Scalable processors (formerly codenamed "Cooper Lake" or CPX6)

- 14 nm process technology
- Six DDR4 memory channels
- 48 PCle 3.0 I/O lanes
- 1 MB L2 cache
- 1.375 MB or more L3 cache per core
- Six Intel Ultra Path Interconnect (UPI) links at 10.4 GT/s
- Intel Hyper-Threading Technology
- Intel Turbo Boost Technology 2.0
- Intel Advanced Vector Extensions 512 (AVX-512)
- Vector Neural Network Instructions (VNNI)
- Enhanced Deep Learning Boost (bfloat16)
- Intel Speed Select support (SST-TF and SST-CP)
- Intel Persistent Memory 200 Series support

The processors include a suffix letter in the processor model number:

- H: 4-Socket capable processor, supports memory up to 1.125TB per processor
- HL: 4-Socket capable, with large memory tier (supports memory up to 4.5TB per processor)

The four processors are connected together using a mesh topology. A mesh topology allows all four processors to be connected together which improves the performance of processor-to-processor communications. The SR860 V2 implements a mesh topology using 6 UPI links. The following figure shows how the SR860 V2 mesh topology is different to the ring topology of the SR850 server and the mesh topology of the SR850P server.

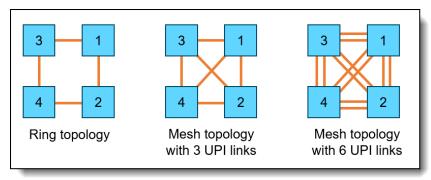


Figure 9. Ring toplogy (SR850) versus 3-UPI Mesh topology (SR850P) versus 6-UPI Mesh topology (SR860 V2)

Table 6. Processor options

Part number	Feature code	Description
4XG7A63392	вв9К	ThinkSystem SR850/SR860 V2 Gold 5318H 18C 150W 2.5GHz Processor
4XG7A63391	BB9J	ThinkSystem SR850/SR860 V2 Gold 5320H 20C 150W 2.4GHz Processor
4XG7A63389	BB9F	ThinkSystem SR850/SR860 V2 Gold 6328H 16C 165W 2.8GHz Processor
4XG7A63486	BD8D	ThinkSystem SR850/SR860 V2 Gold 6328HL 16C 165W 2.8GHz Processor
4XG7A63390	BB9G	ThinkSystem SR850/SR860 V2 Gold 6330H 24C 150W 2.0GHz Processor
4XG7A63388	BB9E	ThinkSystem SR850/SR860 V2 Gold 6348H 24C 165W 2.3GHz Processor
4XG7A63386	BB9C	ThinkSystem SR850/SR860 V2 Platinum 8353H 18C 150W 2.5GHz Processor
4XG7A63387	BB9D	ThinkSystem SR850/SR860 V2 Platinum 8354H 18C 205W 3.1GHz Processor
4XG7A63394	вв9М	ThinkSystem SR850/SR860 V2 Platinum 8356H 8C 190W 3.9GHz Processor
4XG7A63385	BB9B	ThinkSystem SR850/SR860 V2 Platinum 8360H 24C 225W 3.0GHz Processor
4XG7A63505	BDXU	ThinkSystem SR850/SR860 V2 Platinum 8360HL 24C 225W 3.0GHz Processor
4XG7A63384	BB9A	ThinkSystem SR850/SR860 V2 Platinum 8376H 28C 205W 2.6GHz Processor

Part number	Feature code	Description
4XG7A63485	BD8E	ThinkSystem SR850/SR860 V2 Platinum 8376HL 28C 205W 2.6GHz Processor
4XG7A63383	BB99	ThinkSystem SR850/SR860 V2 Platinum 8380H 28C 250W 2.9GHz Processor
4XG7A63484	BD8F	ThinkSystem SR850/SR860 V2 Platinum 8380HL 28C 250W 2.9GHz Processor

Memory capacity of processors

Third-generation Xeon Scalable processors are limited to the amount of memory they can address, as follows:

- Processors with an L suffix (eg 8360HL): Up to 4.5 TB per processor (4608 GB per processor)
- Processors without an L suffix (eg 8360H): Up to 1.125 TB per processor (1152 GB per processor)

Tip: In memory calculations for servers, 1024 GB = 1 TB.

The calculation of the total memory per processor includes both the system memory DIMMs and the persistent memory modules installed in the server.

For example, these configurations do not require an L processor:

- A configuration using 12x 64GB DIMMs per processor, which is a total of 768GB per processor
- A configuration using 6x 64GB DIMMs + 6x 128GB PMem per processor, which is a total of 1.125TB per processor

For example, these configurations must have an L processor installed:

- A configuration using 12x 128GB DIMMs per processor, which is a total of 1.5TB per processor
- A configuration using 6x 32GB DIMMs + 6x 256GB PMem, which is a total of 1.6875TB per processor

Processor features

The following table lists the features of the supported third-generation Intel Xeon processors.

Abbreviations used in the table:

- UPI: Ultra Path Interconnect
- TDP: Thermal Design Power
- FMA: Number of Intel AVX-512 Fused-Multiply Add (FMA) units
- HT: Hyper-Threading
- TB: Turbo Boost 2.0
- VT: Virtualization Technology (includes VT-x and VT-d)
- SST-PP: Speed Select Technology Performance Profile
- PMem: Intel Optane Persistent Memory 200 Series support
- RAS: Reliability, Availability, and Serviceability: Std = Standard, Adv = Advanced

The processors that support SST-PP offer three distinct operating points that are defined by a core count with a base speed associated with that core count. The operating point is selected during the boot process and cannot be changed at runtime.

Table 7. Processor specifications

CPU model	Cores / threads	Core speed (Base / TB max)	L3 cache*	Max memory speed	Max memory per CPU	UPI links & speed	FMA units	TDP	H	TB	Λ	SST-PP	PMem	RAS
Intel Xed	on 5300 (C	Gold) processors												
5318H	18 / 36	2.5 / 3.8 GHz	24.75 MB	2666 MHz	1.125 TB	6 / 10.4 GT/s	2	150W	Υ	Υ	Υ	Ν	Υ	Adv
5320H	20 / 40	2.4 / 4.2 GHz	27.5 MB	2666 MHz	1.125 TB	6 / 10.4 GT/s	2	150W	Υ	Υ	Υ	Ν	Υ	Adv
Intel Xed	on 6300 (C	Gold) processors												
6328H	16 / 32	2.8 / 4.3 GHz	22 MB	2933 MHz	1.125 TB	6 / 10.4 GT/s	2	165W	Υ	Υ	Υ	Ν	Υ	Adv
6328HL	16 / 32	2.8 / 4.3 GHz	22 MB	2933 MHz	4.5 TB	6 / 10.4 GT/s	2	165W	Υ	Υ	Υ	N	Υ	Adv
6330H	24 / 48	2.0 / 3.7 GHz	33 MB	2933 MHz	1.125 TB	6 / 10.4 GT/s	2	150W	Υ	Υ	Υ	N	Υ	Adv
6348H	24 / 48	2.3 / 4.2 GHz	33 MB	2933 MHz	1.125 TB	6 / 10.4 GT/s	2	165W	Υ	Υ	Υ	N	Υ	Adv
Intel Xed	on 8300 (F	Platinum) process	ors											
8353H	18 / 36	2.5 / 3.8 GHz	24.75 MB	3200 MHz	1.125 TB	6 / 10.4 GT/s	2	150W	Υ	Υ	Υ	Ν	Υ	Adv
8354H	18 / 36	3.1 / 4.3 GHz	24.75 MB	3200 MHz	1.125 TB	6 / 10.4 GT/s	2	205W	Υ	Υ	Υ	N	Υ	Adv
8356H	8 / 16	3.9 / 4.4 GHz	35.75 MB	2933 MHz	1.125 TB	6 / 10.4 GT/s	2	190W	Υ	Υ	Υ	N	Υ	Adv
8360H	24 / 48	3.0 / 4.2 GHz	33 MB	3200 MHz	1.125 TB	6 / 10.4 GT/s	2	225W	Υ	Υ	Υ	N	Υ	Adv
8360HL	24 / 48	3.0 / 4.2 GHz	33 MB	3200 MHz	4.5 TB	6 / 10.4 GT/s	2	225W	Υ	Υ	Υ	N	Υ	Adv
8376H	28 / 56	2.6 / 4.3 GHz	38.5 MB	3200 MHz	1.125 TB	6 / 10.4 GT/s	2	205W	Υ	Υ	Υ	Ν	Υ	Adv
8376HL	28 / 56	2.6 / 4.3 GHz	38.5 MB	3200 MHz	4.5 TB	6 / 10.4 GT/s	2	205W	Υ	Υ	Υ	Ν	Υ	Adv
8380H	28 / 56	2.9 / 4.3 GHz	38.5 MB	3200 MHz	1.125 TB	6 / 10.4 GT/s	2	250W	Υ	Υ	Υ	Ν	Υ	Adv
8380HL	28 / 56	2.9 / 4.3 GHz	38.5 MB	3200 MHz	4.5 TB	6 / 10.4 GT/s	2	250W	Υ	Υ	Υ	Ν	Υ	Adv

^{*} L3 cache is 1.375 MB per core for all processors except the Platinum 8356H which has 4.47 MB per core

Two-processor configurations

The SR860 V2 can be used with only two processors installed. Most core functions of the server (including the XClarity Controller) are connected to processors 1 and 2 as shown in the System architecture section.

With only two processors, the server has the following capabilities:

- 24 memory DIMMs for a 3TB maximum
- Up to 12 PMem modules
- Slots 1-4 and 9-12 are not available
- GPUs not supported
- NVMe Switch Adapters not supported
- Up to 8x NVMe drives
 - If the 3-slot riser is used for slots 5-7 (Riser 1), then NVMe drives are not supported

Some drive bay configurations require 4 processors. See the table in the Supported drive bay combinations section for details.

Memory options

The SR860 V2 uses Lenovo TruDDR4 memory and supports 12 DIMMs per processor, which corresponds to 48 DIMMs with four processors installed. Each processor has six memory channels with two DIMMs per channel. With 256 GB 3DS RDIMMs installed, a 4-socket server supports a total of 12 TB of system memory.

The SR860 V2 also supports Intel Optane Persistent Memory 200 Series, as described in the Persistent Memory section.

Memory operates at up to 3200 MHz at two DIMMs per channel, depending on the processor model selected. If the processor selected has a memory bus speed of 2666 MHz or 2933 MHz, then all DIMMs will operate at that speed.

The following table lists the memory options that are available for the server.

Lenovo TruDDR4 memory uses the highest quality components that are sourced from Tier 1 DRAM suppliers and only memory that meets the strict requirements of Lenovo is selected. It is compatibility tested and tuned to maximize performance and reliability. From a service and support standpoint, Lenovo TruDDR4 memory automatically assumes the system warranty, and Lenovo provides service and support worldwide.

Table 8. Memory options

Part	Feature		Maximum
number	code	Description	supported
RDIMMs			
4X77A08632	B963	ThinkSystem 16GB TruDDR4 3200MHz (2Rx8 1.2V) RDIMM	48 (12 per processor)
4X77A08633	B964	ThinkSystem 32GB TruDDR4 3200MHz (2Rx4 1.2V) RDIMM	48 (12 per processor)
4X77A08634	B965	ThinkSystem 32GB TruDDR4 3200MHz (2Rx8 1.2V) RDIMM	48 (12 per processor)
4X77A08635	B966	ThinkSystem 64GB TruDDR4 3200MHz (2Rx4 1.2V) RDIMM	48 (12 per processor)
3DS RDIMMs			
4X77A08636	BA62	ThinkSystem 128GB TruDDR4 3200 MHz (2S2Rx4 1.2V) 3DS RDIMM	48 (12 per processor)
4ZC7A08727	B4Y3	ThinkSystem 256GB TruDDR4 2933MHz (8Rx4 1.2V) 3DS RDIMM	48 (12 per processor)

The following rules apply when selecting the memory configuration:

- Only DIMM quantities of 1, 4, 6 or 12 DIMMs per processor are supported
- The server supports RDIMMs and 3DS RDIMMs; UDIMMs and LRDIMMs are not supported
- Mixing RDIMMs and 3DS RDIMMs is not supported
- Mixing 128GB and 256GB 3DS RDIMMs is not supported
- Mixing x4 and x8 DIMMs is supported
- Additional restrictions may apply when mixing DIMM capacities use the Memory Wizard to determine if your memory configuration is supported.
- If 128GB or 256GB 3DS DIMMs are selected, at most 24 front drive bays can be configured

For best performance, consider the following:

- Populate memory DIMMs in quantities of 6 or 12 per processor, so that all memory channels are used.
- Populate memory channels so they all have the same total memory capacity.
- Ensure all memory controllers on a processor socket have the same DIMM configuration.
- All processor sockets on the same physical server should have the same DIMM configuration.

The following memory protection technologies are supported:

- ECC
- SDDC (for x4-based memory DIMMs; look for "x4" in the DIMM description)
- ADDDC (for x4-based memory DIMMs)
- Memory mirroring

Note: Memory sparing is not supported

If memory channel mirroring is used, then DIMMs must be installed in pairs or sets of three (minimum of one pair or set of three per processor), and all DIMMs in the pair or set of three must be identical in type and size. 50% of the installed capacity is available to the operating system. Memory rank sparing is not supported.

Persistent memory

The SR860 V2 server supports Intel Optane Persistent Memory 200 Series, a new class of memory and storage technology explicitly architected for data center usage. Persistent memory is an innovative technology that delivers a unique combination of affordable large memory capacity and persistence (non-volatility). It offers significantly lower latency than fetching data from SSDs, even NVMe SSDs, and offers higher capacities than system memory.

Persistent memory technology can help boost the performance of data-intensive applications such as SAP HANA. When data is stored closer to the processor on nonvolatile media, applications can see significant overall improvement in performance.

The following table lists the ordering information for the supported persistent memory modules.

Table 9. Persistent memory module part numbers

Part number	Feature code	Description	Maximum supported
4ZC7A08732	B98B	ThinkSystem 128GB TruDDR4 3200MHz (1.2V) Intel Optane Persistent Memory	24 (6 per processor)
4ZC7A08734	B98A	ThinkSystem 256GB TruDDR4 3200MHz (1.2V) Intel Optane Persistent Memory	24 (6 per processor)
4ZC7A08736	BB8T	ThinkSystem 512GB TruDDR4 3200MHz (1.2V) Intel Optane Persistent Memory	24 (6 per processor)

The following are the requirements when installing persistent memory (PMem) modules:

- Only App Direct Mode is supported. Memory Mode and Mixed Mode are not supported.
- All processors that the SR860 V2 supports also support the PMem modules listed in the table below.
- All PMem modules operate at 2666 MHz. Installed memory DIMMs will also operate at 2666 MHz.
- All installed PMem modules must be the same size. Mixing PMem modules of different capacities is not supported.
- Maximum 6 PMem modules per processor (install 1 in each memory channel).
- For each memory channel with both a PMem module and a memory DIMM installed, the PMem module is installed in channel slot 1 (DIMM1, closer to the processor) and the DIMM is installed in channel slot 0 (DIMM0).
- Both interleaved and non-interleaved modes are supported.
- To maximize performance, balance all memory channels
- Memory mirroring is not supported with PMem modules installed
- At most 24x 2.5-inch drives can be installed when any PMem modules are installed. The lower

backplanes (BP4, BP5 and BP6) must remain unpopulated.

- Ambient temperature cannot exceed 30°C
- Only the following operating systems support PMem modules in the SR860 V2:
 - SUSE Linux Enterprise Server 15 SP2 or later
 - SUSE Linux Enterprise Server 15 Xen SP2 or later

In App Direct Mode, only the combinations of RDIMMs and PMem modules listed in the following table are supported. A required RDIMM:PMem ratio of between 1:1 and 1:4 must be met.

Tip: 16GB DIMMs are not supported in App Direct Mode because they do not meet the required 1:4 ratio.

Table 10. Supported App Direct Mode RDIMM/PMem combinations

Total installed				of memer proce	ory RDIN ssor)	Ms		of persistent les (per proc		
per processor	mode ratio*	16GB	32GB	64GB	128GB	256GB	128GB PMem	256GB PMem	512GB PMem	Processor required†
960 GB	1:4		6				6			H or HL
1.125 TB	1:2			6			6			H or HL
1.5 TB	1:1				6		6			HL required
1.875 TB	1:4			6				6		HL required
2.25 TB	1:2				6			6		HL required
3.75 TB	1:4				6				6	HL required

^{*} Ratio of system memory to persistent memory, RDIMM:PMem; 4-Socket-capable third-generation Intel Xeon Scalable processors only support DIMM:Pmem ratios of between 1:1 and 1:4

PMem modules offer the following memory protection technologies:

- ECC
- Device failure recovery SDDC
- Die sparing DDDC
- Patrol scrubbing

For more information, see the Intel Optane Persistent Memory 200 Series product guide, https://lenovopress.com/LP1380

[†] See the Memory capacity of processors section for more information

Internal storage

The SR860 V2 supports up to 48x 2.5-inch SAS/SATA drive bays, up to 24 of which can be NVMe or AnyBay drive bays instead. All 48x drive bays are hot-swap and all front-accessible. The server also supports internal M.2 drives (one or two, installed in an adapter), or rear-accessible hot-swap 7mm SSDs.

Note: M.2 and 7mm drive support is mutually exclusive, as they both use the same connectors.

In this section:

- NVMe drive support
- Front drive bays
- Supported drive bay combinations
- Controller selections
- Field upgrades
- Cable kits for field upgrades
- M.2 drives
- 7mm drives
- SED encryption key management with ISKLM

NVMe drive support

The SR860 V2 supports up to 24x NVMe drives to maximize storage performance.

- Up to 16 NVMe drives with direct connections to the processors
 - No oversubscription (each x4 drive has a full x4 (4 lanes) connection to the processor)
 - 4 drives are connected to each processor for balanced performance
 - 16 NVMe drives precludes the use of the 3-slot riser (Slots 5-7). See I/O expansion options for details.
- Up to 24 NVMe drives using direct connections plus NVMe switch adapters
 - No oversubscription (each x4 drive has a full x4 (4 lanes) connection to the processor)
 - Each 1610-8P switch adapter only has 4 drives attached (no oversubscription)

Riser 1 support with NVMe drives: The use of the 3-slot riser for Riser 1 is mutually exclusive with 8 of the onboard NVMe ports as they use the same connectors. See the System architecture and I/O expansion options sections for details.

The specifics of these configurations are covered in the Supported drive bay combinations and Controller selections sections.

The tables in those sections indicate the number of NVMe drives in each configuration plus the subscription ratio. The subscription ratio is the number of PCIe lanes from the processor compared to the number of lanes to the drives. A ratio of 1:1 means all drives get the full number of lanes they need to maximize drive performance (currently 4 lanes per drive). A ratio of 1:2 means each drive only gets the half the bandwidth from the processor.

In addition, the server supports two 7mm NVMe drives for use as boot drives. These two drives are connected via separate RAID controller connected to a single PCle 3.0 x2 host interface. See the 7mm drives section for details.

Front drive bays

The front drive bay are configured using 8-bay backplanes. The three available backplanes are:

- 8-bay 2.5-inch SAS/SATA backplane
- 8-bay 2.5-inch AnyBay backplane
- 8-bay 2.5-inch NVMe backplane

Tip: The SR860 V2 does not support 3.5-inch drive bays.

The locations of the backplanes is shown in the following figure.

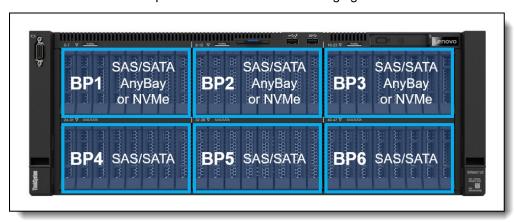


Figure 10. Backplanes

The server supports combinations of these drive backplanes as listed in the Supported drive bay combinations section.

Ordering information for the backplanes is listed in the following table.

Field upgrades: All front backplanes are available as part numbers for field upgrades along with require cable option kits, as described in the Field upgrades section below.

Table 11. Backplanes for front drive bays

Feature code	Description	Maximum supported
B8LU	ThinkSystem 2U 8x2.5" SAS/SATA Backplane	6
B8LM	ThinkSystem 2U/4U 8x2.5" AnyBay Backplane	3
BCQM	ThinkSystem 2U/4U 8x2.5" NVMe Backplane	3

Common backplanes: The AnyBay and NVMe backplanes listed in the above table use the same physical circuit board. Feature codes B8LM and BCQM use a backplane with eight bays where each bay has both a SAS/SATA connection and an NVMe connection. The difference is which connectors on the backplane are cabled: NVMe and SAS/SATA or just NVMe. Both feature codes use backplane SBB7A06906.

Supported drive bay combinations

The following table shows the supported drive bay combinations - SAS/SATA, AnyBay or NVMe drives. The table lists the backplanes required for each drive bay combination.

Some configurations require 4 processors be installed. This is noted in the table.

The table also indicates whether the combination permits the use of the 3-slot riser in Riser 1 (slots 5-7). Those configurations that don't support the 3-slot riser have 16 or more AnyBay or NVMe drives, or are an upgrade path for 16 drives. Such configurations can use the 2-slot riser (slots 5 & 6) instead.

The choice of storage controller for each configuration is listed in the Controller selections section.

Table 12. Drive bay combinations (Blue = SAS/SATA, Purple = AnyBay, Red = NVMe)

Cfg	CPUs	Total drives	Total NVMe§	SAS/SATA drives	AnyBay drives	NVMe drives	Front backplanes	3-Slot Riser support‡
Α	2 or 4	8	0	8	0	0	1x SAS/SATA	Yes*
В	2 or 4	16	0	16	0	0	2x SAS/SATA	Yes
С	2 or 4	24	0	24	0	0	3x SAS/SATA	Yes
D	2 or 4	32	0	32	0	0	4x SAS/SATA	Yes
Е	2 or 4	48	0	48	0	0	6x SAS/SATA	Yes
F	2 or 4	8	8 (1:1)	0	8	0	1x AnyBay	Yes*
G	4	16	16 (1:1)	0	16	0	2x AnyBay	No
Н	4	8	8 (1:1)	0	0	8	1x NVMe	No
I	4	16	16 (1:1)	0	0	16	2x NVMe	No
J	4	24	24 (1:1)	0	0	24	3x NVMe	No
K	2 or 4	16	8 (1:1)	8	8	0	1x SAS/SATA + 1x AnyBay	Yes*
L	4	24	16 (1:1)	8	16	0	1x SAS/SATA + 2x AnyBay	No
М	4	32	24 (1:1)	8	24	0	1x SAS/SATA + 3x AnyBay	No
N	2	24	8 (1:1)	16	8	0	2x SAS/SATA + 1x AnyBay	No
0	4	32	16 (1:1)	16	16	0	2x SAS/SATA + 2x AnyBay	No
Р	2 or 4	32	8 (1:1)	24	8	0	3x SAS/SATA + 1x AnyBay	Yes*
Q	4	48	24 (1:1)	24	24	0	3x SAS/SATA + 3x AnyBay	No
R	4	48	16 (1:1)	32	16	0	4x SAS/SATA + 2x AnyBay	Yes*
S	2	48	8 (1:1)	40	8	0	5x SAS/SATA + 1x AnyBay	No
Т	4	24	16 (1:1)	8	0	16	1x SAS/SATA + 2x NVMe	No
U	4	48	24 (1:1)	24	0	24	3x SAS/SATA + 3x NVMe	No

[§] The text in parenthesis refers to the subscription ratio. See the NVMe support section for details.

[‡] Configurations that have 16 AnyBay or NVMe drives (or are an upgrade path for 16 drives) do not support the use of the 3-Slot Riser (Riser Z, slots 5-7)

^{*} Depending on the controllers used in this configuration, the 3-Slot Riser may not be supported. See Controller selections section for details.

Controller selections

This section helps you determine with storage adapter are supported for your desired drive bay configuration.

In the tables, the controllers are grouped as follows:

- RAID/HBA 8i corresponds to any of the following:
 - ThinkSystem RAID 530-8i PCIe 12Gb Adapter, 7Y37A01082
 - ThinkSystem RAID 930-8i 2GB Flash PCIe 12Gb Adapter, 7Y37A01084
 - ThinkSystem RAID 940-8i 4GB Flash PCIe Gen4 12Gb Adapter, 4Y37A09728
 - ThinkSystem RAID 940-8i 8GB Flash PCle Gen4 12Gb Adapter, 4Y37A09729
 - ThinkSystem 430-8i SAS/SATA 12Gb HBA, 7Y37A01088
- RAID/HBA 16i corresponds to any of the following:
 - ThinkSystem RAID 530-16i PCle 12Gb Adapter, 4Y37A09727
 - ThinkSystem RAID 930-16i 4GB Flash PCle 12Gb Adapter, 7Y37A01085
 - ThinkSystem RAID 940-16i 8GB Flash PCle Gen4 12Gb Adapter, 4Y37A09730
 - ThinkSystem 430-16i SAS/SATA 12Gb HBA, 7Y37A01089
- RAID 32i corresponds to the following:
 - o ThinkSystem RAID 940-32i 8GB Flash PCle Gen4 12Gb Adapter, 4Y37A09733
- 1610-8P corresponds to the following:
 - ThinkSystem 1610-8P NVMe Switch Adapter, 4Y37A09764
- OB SATA (onboard SATA) corresponds to the following in CTO orders:
 - On Board SATA Software RAID Mode, feature AVV0
- OB NVMe (onboard NVMe) corresponds to the following in CTO orders:
 - Non RAID NVMe, feature BC4V
 - Intel VROC (VMD NVMe RAID) Intel SSD Only, feature B9X7
 - Intel VROC (VMD NVMe RAID) Premium, feature B96G

All configurations also support the 7mm rear drive bays (which can can be either SATA or NVMe), or they can support M.2 drives. See the 7mm drives and M.2 drives sections for details. 7mm drive support and M.2 drive support is mutually exclusive.

The following table lists the supported drive bay combinations, plus the list of supported controller combinations supported by each of those drive bay combinations. Information about the controllers can be found in the Controllers for internal storage section.

Some configurations require 4 processors be installed. This is noted in the table.

The table also indicates whether the combination permits the use of the 3-slot riser (slots 5-7). Those configurations that don't support the 3-slot riser have 16 or more AnyBay or NVMe drives, or are an upgrade path for 16 drives. Such configurations can use the 2-slot riser (slots 5 & 6) instead.

Configuration numbering: The letters A-R in the first column matches the configurations listed in the table in the preceding section.

Table 13. Controller selections (Blue = SAS/SATA, Purple = AnyBay, Red = NVMe)

Cfg	SAS/SATA drives	AnyBay drives	NVMe drives	CPUs	3-Slot Riser support	Adapter combinations (drive count) (OB = Onboard)
Α	8	0	0	2 or 4	Yes	OB SATA (8)
				2 or 4	Yes	1x RAID/HBA 8i (8)
				4	No	1x RAID/HBA 8i (8)
				2 or 4	Yes	1x RAID/HBA 16i (16)
В	16	0	0	2 or 4	Yes	1x RAID/HBA 16i (16)

	SAS/SATA	AmuDau	NI) /B/I o		3-Slot	
Cfg	drives	AnyBay drives	NVMe drives	CPUs	Riser support	Adapter combinations (drive count) (OB = Onboard)
С	24	0	0	2 or 4	Yes	OB SATA (8) + 1x RAID/HBA 16i (16)
				2 or 4	Yes	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16)
D	32	0	0	2 or 4	Yes	1x RAID 32i (32)
				2 or 4	Yes	2x RAID/HBA 16i (16+16)
Е	48	0	0	2 or 4	Yes	OB SATA (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24)
				2 or 4	Yes	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24)
				2 or 4	Yes	1x RAID 32i (32) + 1x RAID/HBA 16i (16)
				2 or 4	Yes	3x RAID/HBA 16i (16+16+16)
F	0	8	0	2 or 4	No	OB SATA (8) + OB NVMe (8)
				2 or 4	No	1x RAID/HBA 8i (8) + OB NVMe (8)
				4	Yes	OB SATA (8) + OB NVMe (8) (NVMe connectors on expansion tray)
				4	Yes	1x RAID/HBA 8i (8) + OB NVMe (8) (NVMe connectors on expansion tray)
G	0	16	0	4	No	1x RAID/HBA 16i (16) + OB NVMe (16)
				4	Yes	1x RAID/HBA 16i (16) + OB NVMe (8) + 2x 1610-8P (4+4)
Н	0	0	8	4	No	OB NVMe (8)
I	0	0	16	4	No	OB NVMe (16)
J	0	0	24	4	No	OB NVMe (16) + 2x 1610-8P (4+4)
K	8	8	0	2 or 4	No	1x RAID/HBA 16i (16) + OB NVMe (8)
				4	Yes	1x RAID/HBA 16i (16) + OB NVMe (8) (NVMe connectors on expansion tray)
L	8	16	0	4	No	OB SATA (8) + 1x RAID/HBA 16i (16) + OB NVMe (16)
				4	No	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16) + OB NVMe (16)
				4	Yes	OB SATA (8) + 1x RAID/HBA 16i (16) + OB NVMe (8) + 2x 1610-8P (4+4)
				4	Yes	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16) + OB NVMe (8) + 2x 1610-8P (4+4)
М	8	24	0	4	No	1x RAID 32i (32) + OB NVMe (16) + 2x 1610-8P (4+4)
				4	No	2x RAID/HBA 16i (16+16) + OB NVMe (16) + 2x 1610-8P (4+4)
N	16	8	0	2	No	OB SATA (8) + 1x RAID/HBA 16i (16) + OB NVMe (8)
				2	No	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16) + OB NVMe (8)
0	16	16	0	4	No	1x RAID 32i (32) + OB NVMe (16)
				4	Yes	1x RAID 32i (32) + OB NVMe (8) + 2x 1610-8P (4+4)
				4	Yes	2x RAID/HBA 16i (16+16) + OB NVMe (8) + 2x 1610-8P (4+4)
Р	24	8	0	2 or 4	No	1x RAID 32i (32) + OB NVMe (8)
				2	No	2x RAID/HBA 16i (16+16) + OB NVMe (8)
				4	Yes	1x RAID 32i (32) + OB NVMe (8) (NVMe connectors on expansion tray)
Q	24	24	0	4	No	OB SATA (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (16) + 2x 1610-8P (4+4)
				4	No	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (16) + 2x 1610-8P (4+4)
				4	No	1x RAID/HBA 16i (16) + 1x RAID 32i (32) + OB NVMe (16) + 2x 1610-8P (4+4)
				4	No	3x RAID/HBA 16i (16+16+16) + OB NVMe (16) + 2x 1610-8P (4+4)
R	32	16	0	4	No	OB SATA (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (16)

Cfg	SAS/SATA drives	AnyBay drives	NVMe drives	CPUs	3-Slot Riser support	Adapter combinations (drive count) (OB = Onboard)
				4	Yes	OB SATA (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (8) + 2x 1610-8P (4+4)
				4	No	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (16)
				4	No	1x RAID 32i (32) + 1x RAID/HBA 16i (16) + OB NVMe (16)
				4	Yes	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (8) + 2x 1610-8P (4+4)
				4	Yes	1x RAID 32i (32) + 1x RAID/HBA 16i (16) + OB NVMe (8) + 2x 1610-8P (4+4)
				4	Yes	3x RAID/HBA 16i (16+16) + OB NVMe (8) + 2x 1610-8P (4+4)
				4	No	3x RAID/HBA 16i (16+16) + OB NVMe (16)
S	40	8	0	2	No	OB SATA (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (8)
				2	No	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (8)
				2	No	1x RAID 32i (32) + 1x RAID/HBA 16i (16) + OB NVMe (8)
				2	No	3x RAID/HBA 16i (16+16+16) + OB NVMe (8)
Т	8	0	16	4	No	1x RAID/HBA 8i (8) + OB NVMe (16)
U	24	0	24	4	No	1x RAID 32i (32) + OB NVMe (16) + 2x 1610-8P (4+4)

Field upgrades

The SR860 V2 is orderable without drive bays, allowing you to add a backplane, cabling and controllers as field upgrades. The server also supports upgrading some configurations by adding additional front drive bays, adapters, and cables.

Each row of the following table represents a supported upgrade path. Any other upgrades may not be supported.

Configuration numbering: The letters A-R in the first two columns match the configurations listed in the tables in the preceding sections.

To add drive bays you will need to order both drive backplanes and cable kits. Backplane kits do not include cables.

Table 14. Field upgrades

Starting Target		ting dri d contr	ve bays oller(s)	Target drive bays and controller(s)			Parts needed for upgrade (adapters*, backplanes	
config	config	S/S	Any	NVMe	S/S	Any	NVMe	and cables). All components needed for upgrade.
Α	В	8	0	0	16	0	0	 1x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit
		1x RA	ID/HBA	. 16i (16)	1x RA	AID/HBA	16i (16)	• 1x 4X97A59803, 16i/32i RAID Cable Kit
Α	D	8	0	0	32	0	0	1x RAID/HBA 16i Adapter
		1x RA	ID/HBA	. 16i (16)	2x RAID/HBA 16i (16+16) • 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Ba • 1x 4X97A59803, 16i/32i RAID Cable Kit		 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit 	
Α	E	8	0	0	48	0	0	2x RAID/HBA 16i Adapters
		1x RA	ID/HBA	. 16i (16)	_	AID/HBA 6+16)	. 16i	 5x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit
Α	С	8	0	0	24	0	0	1x RAID/HBA 16i Adapter
		1x RA	ID/HBA	. 8i (8)		AID/HBA 8i (8) + AID/HBA 16i (16)		 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit

Starting	Target		ting dri d contr	ve bays oller(s)	_	et drive controll	bays and er(s)	Parts needed for upgrade (adapters*, backplanes
config	config	S/S	Any	NVMe	S/S	Any	NVMe	and cables). All components needed for upgrade.
A	Е	8	0	0	48	0	0	1x RAID/HBA 16i Adapter
		1x RA	AID/HBA	. 8i (8)	1x RA		. 8i (8) + . 16i (16) i (24)	 1x RAID 32i Adapter 5x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
A	R	8	0	0	32	16	0	1x RAID/HBA 16i Adapter
		1x RA	AID/HBA	. 8i (8)	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (16)			 1x RAID 32i Adapter 2x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit 1x 4X97A59830, System Board PCle NVMe Cable Kit 1x 4X97A59821, Expansion Tray PCle NVMe Cable Kit
A	С	8	0	0	24	0	0	1x RAID/HBA 16i Adapter
		OB S	ATA (8)			ATA (8) /HBA 16		 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
Α	Е	8	0	0	48	0	0	1x RAID/HBA 16i Adapter
		OB S	ATA (8)		RAID	ATA (8) /HBA 16 AID 32i (:	6i (16) +	 1x RAID 32i Adapter 5x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
В	D	16	0	0	32	0	0	1x RAID/HBA 16i Adapter
		1x RA	AID/HBA	. 16i (16)	2x RA (16+1	ND/HBA 6)	. 16i	 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit
В	Е	16	0	0	48	0	0	2x RAID/HBA 16i Adapters
		1x RA	AID/HBA	. 16i (16)		ND/HBA 6+16)	. 16i	 4x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit
С	E	24	0	0	48	0	0	1x RAID 32i Adapter
				. 8i (8) + . 16i (16)	1x RA		. 8i (8) + . 16i (16) i (24)	 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
С	Е	24	0	0	48	0	0	1x RAID 32i Adapter
			ATA (8) /HBA 16		OB SATA (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24)			 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
D	Е	32	0	0	48	0	0	1x RAID/HBA 16i Adapter
		1x RA	AID 32i (32)		ND 32i (/HBA 16	32) + 1x 3i (16)	 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit
D	Е	32	0	0	48	0	0	1x RAID/HBA 16i Adapter 1x RAID/HBA 16i Adapter
		2x RA (16+1	AID/HBA 6)	. 16i		ND/HBA 6+16)	. 16i	 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit
F	N	0	8	0	16	8	0	1x RAID/HBA 16i Adapter
			ND/HBA VMe (8)	8i (8) +	1x RA		8i (8) + 16i (16) 8)	 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
F	N	0	8	0	16	8	0	1x RAID/HBA 16i Adapter
			ND/HBA VMe (8)	. 8i (8) +	1x RA		. 8i (8) + . 16i (16) 8)	 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
F	Р	0	8	0	24	8	0	1x RAID/HBA 16i Adapter
								 1x RAID 32i Adapter 5x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit

Starting	Target	Starting drive bays and controller(s)	Target drive bays and controller(s)	Parts needed for upgrade (adapters*, backplanes
config	config	S/S Any NVMe	S/S Any NVMe	and cables). All components needed for upgrade.
		1x RAID/HBA 8i (8) + OB NVMe (8)	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (8)	
F	Р	0 8 0	24 8 0	1x RAID/HBA 16i Adapter
		1x RAID/HBA 8i (8) + OB NVMe (8)	1x RAID/HBA 8i (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (8)	 1x RAID 32i Adapter 5x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
F	L	0 8 0	8 16 0	1x RAID/HBA 16i Adapter
		OB SATA (8) + OB NVMe (8)	OB SATA (8) + 1x RAID/HBA 16i (16) + OB NVMe (16)	 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 1x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit 1x 4X97A59821, Expansion Tray PCIe NVMe Cable Kit
F	N	0 8 0	16 8 0	1x RAID/HBA 16i Adapter
		OB SATA (8) + OB NVMe (8)	OB SATA (8) + 1x RAID/HBA 16i (16) + OB NVMe (8)	 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
F	S	0 8 0	40 8 0	1x RAID/HBA 16i Adapter
		OB SATA (8) + OB NVMe (8)	OB SATA (8) + 1x RAID/HBA 16i (16) + 1x RAID 32i (24) + OB NVMe (8)	 1x RAID 32i Adapter 5x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
G	М	0 16 0	8 24 0	1x RAID/HBA 16i Adapter
		1x RAID/HBA 16i (16) + OB NVMe (16)	2x RAID/HBA 16i (16+16) + OB NVMe (16) + 2x 1610-8P (4+4)	 2x 1610-8P NVMe Switch Adapters 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 1x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit 1x 4X97A59822, Switch/Retimer NVMe Cable Kit
G	Q	0 16 0	24 24 0	2x RAID/HBA 16i Adapters
		1x RAID/HBA 16i (16) + OB NVMe (16)	3x RAID/HBA 16i (16+16+16) + OB NVMe (16) + 2x 1610- 8P (4+4)	 2x 1610-8P NVMe Switch Adapters 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit 1x 4X97A59822, Switch/Retimer NVMe Cable Kit
G	R	0 16 0	32 16 0	2x RAID/HBA 16i Adapters
		1x RAID/HBA 16i (16) + OB NVMe (16)	3x RAID/HBA 16i (16+16) + OB NVMe (16)	 4x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit
Н	G	0 0 8	0 16 0	• 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit
		1x RAID/HBA 16i (16) + OB NVMe (8)	1x RAID/HBA 16i (16) + OB NVMe (16)	 Remove 1x existing SAS/SATA backplane 1x 4X97A59821, Expansion Tray PCle NVMe Cable Kit
Н	М	0 0 8	8 24 0	1x RAID/HBA 16i Adapter
		1x RAID/HBA 16i (16) + OB NVMe (8)	2x RAID/HBA 16i (16+16) + OB NVMe (16) + 2x 1610-8P (4+4)	 2x 1610-8P NVMe Switch Adapters 2x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit 1x 4X97A59821, Expansion Tray PCle NVMe Cable Kit 1x 4X97A59822, Switch/Retimer NVMe Cable Kit
Н	Р	0 0 8	24 8 0	1x RAID/HBA 16i Adapter
		1x RAID/HBA 16i (16) + OB NVMe (8)	2x RAID/HBA 16i (16+16) + OB NVMe (8)	 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit

Starting	Target		rting dr d contr	ive bays oller(s)		et drive controll	bays and er(s)	Parts needed for upgrade (adapters*, backplanes
config	config	S/S	Any	NVMe	S/S	Any	NVMe	and cables). All components needed for upgrade.
Н	Q		0 AID/HBA NVMe (8 A 16i (16) (8)	(16+1	. ,		 2x RAID/HBA 16i Adapters 2x 1610-8P NVMe Switch Adapters 2x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit 1x 4X97A59821, Expansion Tray PCle NVMe Cable Kit 1x 4X97A59822, Switch/Retimer NVMe Cable Kit
H	R		0 AID/HBA NVMe (8 x 16i (16) (8)		16 AID/HBA 6) + OB		 2x RAID/HBA 16i Adapters 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit 1x 4X97A59821, Expansion Tray PCle NVMe Cable Kit
Н	S		0 AID/HBA NVMe (8 A 16i (16) (8)		8 AID/HBA 6+16) + e (8)		 2x RAID/HBA 16i Adapters 4x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit
Н	I	0 OB N	0 VMe (8)	8	0 OB N	0 VMe (16	16 S)	 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 1x 4X97A59821, Expansion Tray PCle NVMe Cable Kit
Н	J	0 OB N	0 VMe (8)	8		0 VMe (16 8P (4+4		 2x 1610-8P NVMe Switch Adapters 2x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 1x 4X97A59821, Expansion Tray PCle NVMe Cable Kit 1x 4X97A59822, Switch/Retimer NVMe Cable Kit
Н	Т	0 OB N	0 VMe (8)	8		0 AID/HBA VMe (16	16 38i (8) + 3)	 1x RAID/HBA 8i Adapter 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 1x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59821, Expansion Tray PCle NVMe Cable Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
Н	U	0 OB N	0 VMe (8)	8		e (16) +	24 32) + OB 2x 1610-	 1x RAID 32i Adapter 2x 1610-8P NVMe Switch Adapters 2x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit 1x 4X97A59821, Expansion Tray PCIe NVMe Cable Kit 1x 4X97A59822, Switch/Retimer NVMe Cable Kit
I	J	0 OB N	0 VMe (10	16 6)		0 VMe (16 8P (4+4		 2x 1610-8P NVMe Switch Adapters 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 1x 4X97A59822, Switch/Retimer NVMe Cable Kit
I	Т	0 OB N	0 VMe (10	16 6)	8 1x RA	0	16 8i (8) +	 1x RAID/HBA 8i Adapter 1x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
1	U	0 OB N	0 VMe (16	16 6)	24 1x RA	0 AID 32i (e (16) +	24 32) + OB 2x 1610-	 1x RAID 32i Adapter 2x 1610-8P NVMe Switch Adapters 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit 1x 4X97A59822, Switch/Retimer NVMe Cable Kit
J	U		0 VMe (16 -8P (4+4	,		e (16) +	24 32) + OB 2x 1610-	 1x RAID 32i Adapter 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit

Starting	Target			ve bays oller(s)		t drive controll	bays and er(s)	Parts needed for upgrade (adapters*, backplanes
config	config	S/S A	Any	NVMe	S/S	Any	NVMe	and cables). All components needed for upgrade.
L	Р	1x RAID	/HBA	16i (16)	1x RA + 1x F			 1x RAID 32i Adapter 4x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Ki Remove 1x existing AnyBay backplane 1x 4X97A59802, Onboard/8i RAID Cable Kit Remove 2x existing NVMe cables
L	R	1x RAID	/HBA	16ì (16)	1x RA + 1x F			 1x RAID 32i Adapter 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
L	R	OB SATA RAID/HE OB NVM	3A 16	i (16) +	RAID/			 1x RAID 32i Adapter 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit
M	Q	1x RAID	16) +	0 32) + OB 2x 1610-	24 1x RA + 1x F OB N	24	s) + 2x	 1x RAID/HBA 16i Adapter 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit
M	R	1x RAID	16) + Ì	0 32) + OB 2x 1610-	RAID/	16 JD 32i (HBA 16 VMe (16		 1x RAID/HBA 16i Adapter Remove 2x 1610-8P NVMe Switch Adapters 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit Remove 1x existing AnyBay backplane 1x 4X97A59803, 16i/32i RAID Cable Kit Remove 2x NVMe adapter cables
M	S	1x RAID	16) + Ì	0 32) + OB 2x 1610-	RAID/	8 JD 32i (HBA 16 VMe (8)	` '	 1x RAID/HBA 16i Adapter Remove 2x 1610-8P NVMe Switch Adapters 4x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Ki Remove 2x existing AnyBay backplanes 1x 4X97A59803, 16i/32i RAID Cable Kit Remove 2x existing NVMe cables Remove 2x NVMe adapter cables
M	R			0 32) + OB	RAID/	16 JD 32i ('HBA 16 VMe (16		 1x RAID/HBA 16i Adapter 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit Remove 1x existing SAS/SATA backplane 1x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit 1x 4X97A59821, Expansion Tray PCIe NVMe Cable Kit
М	S			0 32) + OB	RAID/	8 JD 32i ('HBA 16 VMe (8)	` '	 1x RAID/HBA 16i Adapter 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kii 1x 4X97A59803, 16i/32i RAID Cable Kit
M	Q	8 2x RAID (16+16) (16) + 2x (4+4)	+ OB	NVMe	24 3x RA (16+1	24 ID/HBA 6+16) +	0 16i	 1x RAID/HBA 16i Adapter 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit
M	R	8 2x RAID (16+16) (16) + 2x (4+4)	+ OB	NVMe	32 3x RA	16 IID/HBA 6) + OB		 1x RAID/HBA 16i Adapter Remove 2x 1610-8P NVMe Switch Adapters 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit Remove 1x existing AnyBay backplane 1x 4X97A59803, 16i/32i RAID Cable Kit Remove 2x NVMe adapter cables

Starting	Target	Starting drive bays and controller(s)			Target drive bays and controller(s)			Parts needed for upgrade (adapters*, backplanes				
config	config	S/S	Any	NVMe	S/S	Any	NVMe	and cables). All components needed for upgrade.				
N	Р	1x RA		0 . 8i (8) + . 16i (16) 8)	1x RA + 1x F		` '	 1x RAID 32i Adapter 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit 				
N	S	RAID/I	8 ATA (8) HBA 16 /Me (8)	ii (16) +	RAID			 1x RAID 32i Adapter 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59802, Onboard/8i RAID Cable Kit 				
0	М	16 1x RAI NVMe		0 32) + OB		e (16) +	0 32) + OB 2x 1610-	 2x 1610-8P NVMe Switch Adapters 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit Remove 1x existing SAS/SATA backplane 1x 4X97A59822, Switch/Retimer NVMe Cable Kit 				
0	Q	16 1x RAI NVMe		0 32) + OB	+ 1x F OB N	24 AID/HBA RAID 32 VMe (16 8P (4+4	6) + 2x	 1x RAID/HBA 16i Adapter 2x 1610-8P NVMe Switch Adapters 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 1x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit 1x 4X97A59803, 16i/32i RAID Cable Kit 1x 4X97A59822, Switch/Retimer NVMe Cable Kit 				
0	R	16 1x RAI NVMe		0 32) + OB	RAID	16 AID 32i (/HBA 16 VMe (16		 1x RAID/HBA 16i Adapter 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BF 1x 4X97A59803, 16i/32i RAID Cable Kit 				
0	S	16 1x RAI NVMe		0 32) + OB	RAID	8 AID 32i (/HBA 16 VMe (8)		 1x RAID/HBA 16i Adapter 3x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit Remove 1x existing AnyBay backplane 1x 4X97A59803, 16i/32i RAID Cable Kit Remove 2x existing NVMe cables 				
Р	Q	1x RAI + 1x R	ID/HBA	0 . 8i (8) + . 16i (16) i (24) +	1x RA + 1x F OB N		6) + 2x	 2x 1610-8P NVMe Switch Adapters 2x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit Remove 2x existing SAS/SATA backplanes 1x 4X97A59821, Expansion Tray PCle NVMe Cable Kit 1x 4X97A59822, Switch/Retimer NVMe Cable Kit 				
Р	S		8 ID/HBA 6) + OB	0 16i NVMe		8 AID/HBA 6+16) + e (8)		 1x RAID/HBA 16i Adapter 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP K 1x 4X97A59803, 16i/32i RAID Cable Kit 				
Q	R	+ 1x R OB NV		,	RAID	16 AID 32i (/HBA 16 VMe (16		 Remove 2x 1610-8P NVMe Switch Adapters 1x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit Remove 1x existing AnyBay backplane Remove 2x NVMe adapter cables 				
Q	S	+ 1x R OB NV		.*	RAID	8 AID 32i (/HBA 16 VMe (8)	` '	 Remove 2x 1610-8P NVMe Switch Adapters 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit Remove 2x existing AnyBay backplanes Remove 2x existing NVMe cables Remove 2x NVMe adapter cables 				
Q	R	(16+16	. ,			16 AID/HBA 6) + OB		 Remove 2x 1610-8P NVMe Switch Adapters 1x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP Kit Remove 1x existing AnyBay backplane Remove 2x NVMe adapter cables 				

Starting	Target config	Starting drive bays and controller(s)			Target drive bays and controller(s)			Parts needed for upgrade (adapters*, backplanes			
config		S/S	Any	NVMe	S/S	Any	NVMe	and cables). All components needed for upgrade.			
S	R	40	8	0	32	16	0	• 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit			
		RAID/		32) + 1x 3i (16) +	1x RAID 32i (32) + 1x RAID/HBA 16i (16) + OB NVMe (16)			 Remove 1x existing SAS/SATA backplane 1x 4X97A59821, Expansion Tray PCle NVMe Cable Kit 			
Т	J	8	0	16	0	0	24	2x 1610-8P NVMe Switch Adapters			
		1x RAID/HBA 8i (8) + OB NVMe (16)			OB NVMe (16) + 2x 1610-8P (4+4)			 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit Remove 1x existing SAS/SATA backplane 1x 4X97A59822, Switch/Retimer NVMe Cable Ki 			
Т	U	8	0	16	24	0	24	1x RAID 32i Adapter			
		1x RAID/HBA 8i (8) + OB NVMe (16)			1x RAID 32i (32) + OB NVMe (16) + 2x 1610- 8P (4+4)			 2x 1610-8P NVMe Switch Adapters 1x 4C57A15025, 2U 2.5" AnyBay 8-Bay BP Kit 2x 4C57A15024, 2U 2.5" SAS/SATA 8-Bay BP K 1x 4X97A59802, Onboard/8i RAID Cable Kit 1x 4X97A59822, Switch/Retimer NVMe Cable Kit 			

^{*} Abbreviations such as "RAID/HBA 16i Adapter" refer to a group of supported adapters; these are described in the Controller selections section

Cable kits for field upgrades

The following table lists the contents of each cable kits that is used as described in the preceding Field upgrades section.

Table 15. Contents of the cable option kits

Part number	Description and contents
4X97A59802	ThinkSystem SR860 V2 Onboard/8i RAID Cable Accessories Kit 1x SBB7A16989 - SAS Cable: RAID Card to BP (MiniSAS x8 to 2x Slimline x4), 860mm 1x SBB7A16990 - SAS Cable: RAID Card to BP (MiniSAS x8 to 2x Slimline x4), 1000mm 1x SBB7A16994 - SAS Cable: RAID Card to BP (Slimline x8 to 2x Slimline x4), 690mm 1x SBB7A14680 - SAS Cable: RAID Card to BP (Slimline x8 to 2x Slimline x4), 820mm 1x SBB7A15182 - SAS Cable: RAID Card to BP (Slimline x8 to 2x Slimline x4), 860mm 1x SBB7A15183 - SAS Cable: RAID Card to BP (Slimline x8 to 2x Slimline x4), 1000mm 1x SBB7A14685 - SAS Cable: RAID Card to BP (Slimline x8 to 1x Slimline x8), 665mm
4X97A59803	ThinkSystem SR860 V2 16i/32i RAID Cable Accessories Kit 1x SBB7A16992 - SAS Cable: RAID Card to BP (MiniSAS x8 to 2x Slimline x4), 665mm 1x SBB7A16988 - SAS Cable: RAID Card to BP (MiniSAS x8 to 2x Slimline x4), 820mm 1x SBB7A16989 - SAS Cable: RAID Card to BP (MiniSAS x8 to 2x Slimline x4), 860mm 1x SBB7A15184 - SAS Cable: RAID Card to BP (MiniSAS x8 to 2x Slimline x4), 930mm 1x SBB7A16990 - SAS Cable: RAID Card to BP (MiniSAS x8 to 2x Slimline x4), 1000mm 1x SBB7A14680 - SAS Cable: RAID Card to BP (Slimline x8 to 2x Slimline x4), 820mm 1x SBB7A15182 - SAS Cable: RAID Card to BP (Slimline x8 to 2x Slimline x4), 945mm 1x SBB7A15183 - SAS Cable: RAID Card to BP (Slimline x8 to 2x Slimline x4), 1000mm 1x SBB7A15183 - SAS Cable: RAID Card to BP (Slimline x8 to 2x Slimline x4), 1000mm 1x SBB7A1685 - SAS Cable: RAID Card to BP (Slimline x8 to 1x Slimline x8), 665mm
4X97A59821	ThinkSystem SR860 V2 Expansion Tray PCIe NVMe Cable Accessories Kit 1x SBB7A16998 - PCIe Cable: Sliver to BP (Sliver x16 to 2x MICO x8), 530mm 1x SBB7A23739 - PCIe Cable: Sliver to BP (Sliver x16 to 2x MICO x8), 670mm
4X97A59822	ThinkSystem SR860 V2 Switch/Retimer NVMe Cable Accessories Kit 4 x SBB7A16999 - PCle Cable: Re-Timer Card to BP (Slimline x8 to 1x MICO x8), 970mm
4X97A59829	ThinkSystem SR850 V2 8i/16i RAID Cable Accessories Kit 1x SBB7A16992 - SAS Cable: RAID Card to BP (MiniSAS x8 to 2x Slimline x4), 665mm 1x SBB7A16989 - SAS Cable: RAID Card to BP (MiniSAS x8 to 2x Slimline x4), 860mm 1x SBB7A16990 - SAS Cable: RAID Card to BP (MiniSAS x8 to 2x Slimline x4), 1000mm 1x SBB7A15182 - SAS Cable: RAID Card to BP (Slimline x8 to 2x Slimline x4), 860mm 1x SBB7A15183 - SAS Cable: RAID Card to BP (Slimline x8 to 2x Slimline x4), 1000mm
4X97A59830	ThinkSystem SR860 V2 System Board PCIe NVMe Cable Accessories Kit 1x SBB7A15185 - PCIe Cable: Sliver to BP (Sliver x16 to 2x MICO x8), 670mm 1x SBB7A16997 - PCIe Cable: Sliver to BP (Sliver x16 to 2x MICO x8), 910mm

When adding drive bays, you will also need to add the appropriate storage controller(s). Consult the tables in the Controller selections section to determine what controller sections are supported and what additional controllers you will need. Controllers are described in the Controllers for internal storage section.

M.2 drives

The SR860 V2 supports one or two M.2 form-factor SATA or NVMe drives for use as an operating system boot solution or as additional storage. The M.2 drives install into an M.2 module which is mounted vertically in the server between the two upper riser cards as shown in Figure 6.

M.2 and 7mm drive support: The M.2 module and 7mm drive enclosure connect to the same ports on the system board. As a result, they are mutually exclusive.

There are three different M.2 modules supported, as listed in the following table.

Table 16, M.2 modules

Part number	Feature code	Description	SATA drives	_		Maximum supported
4Y37A09739	B5XH	ThinkSystem M.2 SATA 2-Bay RAID Enablement Kit	Yes	No	Yes	1
4Y37A09750	B8P9	ThinkSystem M.2 NVMe 2-Bay RAID Enablement Kit	No	Yes	Yes	1
4Y37A09738	B5XJ	ThinkSystem M.2 SATA/NVMe 2-Bay Enablement Kit	Yes	Yes	No	1

Supported drives are listed in the Internal drive options section.

The M.2 SATA 2-Bay RAID Enablement Kit has the following features:

- Supports one or two SATA M.2 drives
- Support 42mm, 60mm, 80mm and 110mm drive form factors (2242, 2260, 2280 and 22110)
- RAID support via an onboard Marvell 88SE9230 SATA RAID Controller
- Support JBOD, RAID-0 and RAID-1 (RAID support requires two M.2 drives)
- PCle 2.0 x2 host interface; 6Gbps SATA connection to the drives
- Management and configuration support via UEFI and OS-based tools
- Supports monitoring and reporting of events and temperature through I2C
- Firmware update via Lenovo firmware update tools

The M.2 NVMe 2-Bay RAID Enablement Kit has the following features:

- Supports one or two NVMe M.2 drives
- Support 42mm, 60mm, 80mm and 110mm drive form factors (2242, 2260, 2280 and 22110)
- RAID support via an onboard Marvell 88NR2241 NVMe RAID Controller
- With 1 drive, supports single-drive RAID-0
- With 2 drives, supports 2-drive RAID-0, 2-drive RAID-1, or two single-drive RAID-0 arrays
- PCle 3.0 x2 host interface; PCle 3.0 x1 connection to each drive
- Management and configuration support via UEFI and OS-based tools
- Supports monitoring and reporting of events and temperature through I2C
- Firmware update via Lenovo firmware update tools

The M.2 SATA/NVMe 2-Bay Enablement Kit has the following features:

- Supports one or two M.2 drives, either SATA or NVMe
- When two drives installed, they must be either both SATA or both NVMe
- Support 42mm, 60mm, 80mm and 110mm drive form factors (2242, 2260, 2280 and 22110)
- JBOD native support; no built-in RAID support (RAID can be enabled via Intel VROC)
- Either 6Gbps SATA or PCIe 3.0 x1 interface to the drives depending on the drives installed
- Supports monitoring and reporting of events and temperature through I2C
- Firmware update via Lenovo firmware update tools

For field upgrades, the SR860 V2 also requires an additional M.2 cable kit. Ordering information is listed in the following table.

Table 17. M.2 Cable for field upgrades

Part number	Description
4X97A59828	ThinkSystem SR860 V2 M.2 Cable Accessories Kit • M.2 Signal & Power Cable • Air baffle

For further details about M.2 components, see the *ThinkSystem M.2 Drives and M.2 Adapters* product guide https://lenovopress.com/lp0769-thinksystem-m2-drives-adapters

7mm drives

The SR860 V2 supports two 7mm drives, either both SATA or both NVMe, at the rear of the server. These drives go in the space between the two upper riser cards, as shown in the following figure.

M.2 and 7mm drive support: The M.2 module and 7mm drive enclosure connect to the same ports on the system board. As a result, they are mutually exclusive.

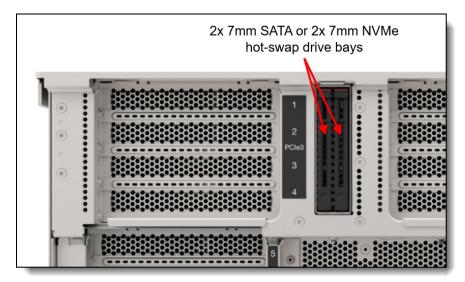


Figure 11. 7mm drive bays

Ordering information for the 7mm drive bays is in the following table.

Table 18. 7mm rear drive bays

Part number	Feature code	Description
4C57A15007	B8P2	ThinkSystem SR860 V2 Rear 7mm SATA SSD RAID Enablement Kit
4C57A15008	B8P3	ThinkSystem SR860 V2 Rear 7mm NVMe SSD RAID Enablement Kit

Each drive enclosure includes an integrated controller providing RAID functions.

The 7mm SATA RAID Drive Kit has the following features:

- Supports 1 or 2 SATA hot-swap drives; drives are 7mm high and 2.5-inches wide
- Integrated controller based on the Marvell 88SE9230 SATA RAID Controller
- PCle 2.0 x2 host interface to the server system board
- Provides 6 Gbps SATA connectivity to the drives
- Supports JBOD, RAID-0 and RAID-1
- Management and configuration support via UEFI and OS-based tools
- Supports monitoring and reporting of events and temperature through I2C
- Firmware update via Lenovo firmware update tools

The 7mm NVMe RAID Drive Kit has the following features:

- Supports 1 or 2 NVMe hot-swap drives; drives are 7mm high and 2.5-inches wide
- Integrated controller based on the Marvell 88NR2241 NVMe RAID Controller
- PCle 3.0 x2 host interface to the server system board
- Provides PCle 3.0 x1 connectivity to each drive
- With 1 drive, supports single-drive RAID-0
- With 2 drives, supports 2-drive RAID-0, 2-drive RAID-1, or two single-drive RAID-0 arrays
- Management and configuration support via UEFI and OS-based tools
- Supports monitoring and reporting of events and temperature through I2C
- Firmware update via Lenovo firmware update tools

SED encryption key management with ISKLM

The server supports self-encrypting drives (SEDs) as listed in the Internal drive options section. To effectively manage a large deployment of these drives in Lenovo servers, IBM Security Key Lifecycle Manager (SKLM) offers a centralized key management solution. A Lenovo Feature on Demand (FoD) upgrade is used to enable this SKLM support in the management processor of the server.

The following table lists the part numbers and feature codes for the upgrades.

Table 19. FoD upgrades for SKLM support

Part number	Feature code	Description			
Security Key Li	Security Key Lifecycle Manager - FoD (United States, Canada, Asia Pacific, and Japan)				
00D9998	A5U1	SKLM for System x/ThinkSystem w/SEDs - FoD per Install with 1 year S&S			
00D9999	AS6C	SKLM for System x/ThinkSystem w/SEDs - FoD per Install with 3 year S&S			
Security Key Li	fecycle Manager	- FoD (Latin America, Europe, Middle East, and Africa)			
00FP648	A5U1	SKLM for System x/ThinkSystem w/SEDs - FoD per Install with 1 year S&S			
00FP649	AS6C	SKLM for System x/ThinkSystem w/SEDs - FoD per Install with 3 year S&S			

Controllers for internal storage

The SR860 V2 supports offers a variety of controller options for internal drives:

- For 2.5-inch drives:
 - Onboard SATA ports with software RAID support (Intel VROC SATA RAID, formerly known as Intel RSTe)
 - Onboard NVMe ports with software RAID support (Intel VROC NVMe RAID)
 - RAID adapters and HBAs for SAS/SATA drives (RAID 940-16i also supports NVMe)
 - NVMe Switch adapter for NVMe drives
- For 7mm drive bays in the rear of the server (see the 7mm drives section)
 - SATA controller integrated into the 7mm drive bay enclosure
 - NVMe controller integrated into the 7mm drive bay enclosure

- For M.2 drives internal to the server (see M.2 drives section)
 - SATA controller integrated on the M.2 SATA 2-Bay RAID Enablement Kit
 - NVMe controller integrated on the M.2 NVMe 2-Bay RAID Enablement Kit

The following table lists the controllers and adapters used for the internal 2.5-inch drive bays of the SR860 V2 server.

Table 20. Controllers for internal storage

Part number	Feature code	Description	Power module (supercap)	Maximum supported	Slots supported	
Onboard SAT	Onboard SATA - 8 drives - Intel VROC SATA RAID (Intel RSTe)					
None	AVV0	On Board SATA Software RAID Mode	No	1	Not applicable	
Onboard NVM	1e - 16 dri	ves - Intel VROC NVMe RAID				
None	B9X7	Intel VROC (VMD NVMe RAID) Intel SSD Only (Standard)	No	1	Not applicable	
4L47A39164	B96G	Intel VROC (VMD NVMe RAID) Premium (license upgrade - to enable RAID support for non-Intel NVMe SSDs)	No	1	Not applicable	
SAS/SATA RA	AID adapte	ers				
7Y37A01082	AUNG	ThinkSystem RAID 530-8i PCIe 12Gb Adapter	No	1	15	
4Y37A09727	BFY5	ThinkSystem RAID 530-16i PCIe 12Gb Adapter	No	3	13,14,15	
7Y37A01084	AUNJ	ThinkSystem RAID 930-8i 2GB Flash PCle 12Gb Adapter	Included	1	15	
7Y37A01085	AUNK	ThinkSystem RAID 930-16i 4GB Flash PCle 12Gb Adapter	Included	3	13,14,15	
4Y37A09728	B8NY	ThinkSystem RAID 940-8i 4GB Flash PCle Gen4 12Gb Adapter	Included	1	15	
4Y37A09729	B8NW	ThinkSystem RAID 940-8i 8GB Flash PCle Gen4 12Gb Adapter	Included	1	15	
4Y37A09730	B8NZ /	ThinkSystem RAID 940-16i 8GB Flash PCle Gen4 12Gb Adapter	Included	3	13,14,15	
4Y37A09733	B8P8	ThinkSystem RAID 940-32i 8GB Flash PCle Gen4 12Gb Adapter	Included	1	5	
SAS/SATA HE	BAs for int	ernal storage				
7Y37A01089	AUNM	ThinkSystem 430-16i SAS/SATA 12Gb HBA	No	3	13,14,15	
7Y37A01088	AUNL	ThinkSystem 430-8i SAS/SATA 12Gb HBA	No	1	15	
NVMe adapte	rs for inter	nal storage				
CTO only	B4PA	ThinkSystem 1610-8P NVMe Switch Adapter	No	2	10,12	

Configuration notes:

- Supercap support limits the number of RAID adapters installable: As indicated in the table, the RAID 930 and RAID 940 adapters include and require a power module (supercap) to power the flash memory. The server supports up to 4 supercaps, installed in a dedicated holder adjacent to the top riser slots as shown in Figure 6. The number of supercaps supported also determines the maximum number of internal + external RAID 930/940 adapters that can be installed in the server.
- **Field upgrades**: The RAID 930 and RAID 940 adapter part numbers include both the supercap and the supercap cable.

• **7mm drive support**: The storage adapters listed in the table below do *not* provide connectivity to the 7mm drive bays that are optionally available at the rear of the server. The 7mm drives have their own independent RAID controller. See the 7mm drives section for details.

The onboard SATA controller has the following features:

- · Controller integrated into the Intel processor
- Supports up to 8 SATA drives
- 6 Gbps SATA host interface
- Supports RAID-0, 1, 5, 10 (Intel VROC SATA RAID, previously known as RSTe)
- Supports JBOD
- Supports HDDs and SSDs; can be mixed

The onboard NVMe support has the following features:

- · Controller integrated into the Intel processor
- Supports up to 16 NVMe drives
- Each drive has PCle 3.0 x4 host interface
- Supports JBOD Intel and non-Intel NVMe SSDs no license required
- Supports RAID-0, 1, 5, 10 (Intel VROC NVMe RAID) Intel NVMe SSDs only unless VROC Premium license is installed
- · VROC Premium also extends to any drives connected via an NVMe Switch Adapter

Intel VROC onboard SATA and NVMe RAID

Intel VROC (Virtual RAID on CPU) is a feature of the Intel processor that enables RAID support. There are two separate functions of VROC:

- Intel VROC SATA RAID, formerly known as Intel RSTe
- Intel VROC NVMe RAID

VROC SATA RAID (RSTe) is available and supported with all SATA drives, both SATA SSDs and SATA HDDs. If offers a 6 Gb/s connection to each drive and on the SR860 V2 implements RAID levels 0, 1, 5, and 10.

VROC NVMe RAID offers RAID support for any NVMe drives directly connected to the ports on the server's system board or via adapters such as NVMe retimers or NVMe switch adapters. On the SR860 V2, it implements RAID levels 0, 1, 5, and 10.

Performance tip: For best performance with VROC NVMe RAID, the drives in an array should all be connected to the same processor. Spanning processors is possible however performance will be unpredictable and should be evaluated based on your workload.

By default, VROC NVMe RAID support is limited to use with only Intel-branded NVMe drives (feature B9X7). If you wish to enable RAID support for non-Intel NVMe SSDs, select the VROC Premium license using the ordering information in the following table. VROC Premium is fulfilled as a Feature on Demand (FoD) license and is activated via the XCC management processor user interface.

Table 21. VROC upgrade

Part number	Feature code	Description
4L47A39164	B96G	Intel VROC (VMD NVMe RAID) Premium

VROC Premium is only needed for non-Intel NVMe drives in a RAID configuration. You do not need the VROC Premium license upgrade under any of the following conditions:

- If you have SATA drives connected to the onboard SATA ports, you do not need VROC Premium
- If you have Intel NVMe drives connected to the onboard NVMe ports, you do not need VROC Premium
- If you have non-Intel NVMe drives connected to the onboard NVMe ports, but you don't want RAID support, you do not need VROC Premium

Virtualization support: Virtualization support for Intel VROC is as follows:

- VROC SATA RAID (RSTe): VROC SATA RAID is not supported by virtualization hypervisors such as ESXi, KVM, Xen, and Hyper-V. Virtualization is only supported on the onboard SATA ports in AHCI (non-RAID) mode.
- VROC (VMD) NVMe RAID: VROC (VMD) NVMe RAID is supported by ESXi, KVM, Xen, and Hyper-V. ESXi support is limited to RAID 1 only; other RAID levels are not supported. Windows and Linux OSes support VROC RAID NVMe, both for host boot functions and for guest OS function, and RAID-0, 1, 5, and 10 are supported.

For specifications about the RAID adapters and HBAs supported by the SR860 V2, see the ThinkSystem RAID Adapter and HBA Comparison, available from:

https://lenovopress.com/lp1288-lenovo-thinksystem-raid-adapter-and-hba-reference#sr860-v2-support=SR860%2520V2

For details about these adapters, see the relevant product guide:

- SAS HBAs: https://lenovopress.com/servers/options/hba
- RAID adapters: https://lenovopress.com/servers/options/raid

Internal drive options

The following tables list the hard disk drive and solid-state drive options for the internal disk storage of the server.

2.5-inch hot-swap drives:

- 2.5-inch hot-swap 12 Gb SAS HDDs
- 2.5-inch hot-swap 6 Gb SATA HDDs
- 2.5-inch hot-swap 12 Gb SAS SSDs
- 2.5-inch hot-swap 6 Gb SATA SSDs
- 2.5-inch hot-swap PCIe 4.0 NVMe SSDs
- 2.5-inch hot-swap PCle 3.0 NVMe SSDs

2.5-inch 7mm hot-swap drives:

- 7mm 2.5-inch hot-swap 6 Gb SATA SSDs
- 7mm 2.5-inch hot-swap PCIe 3.0 NVMe SSDs

M.2 drives:

- M.2 SATA drives
- M.2 NVMe drives

M.2 drive support: The use of M.2 drives requires an additional adapter as described in the M.2 drives subsection.

PCIe 4.0 NVMe drive support: When installed in this server, PCIe 4.0 NVMe drives will operate at PCIe 3.0 speeds.

Table 22. 2.5-inch hot-swap 12 Gb SAS HDDs

Part number	Feature	Description	Maximum supported
		- 12 Gb SAS 10K	1
7XB7A00024	AULY	ThinkSystem 2.5" 300GB 10K SAS 12Gb Hot Swap 512n HDD	48
7XB7A00025	AULZ	ThinkSystem 2.5" 600GB 10K SAS 12Gb Hot Swap 512n HDD	48
7XB7A00027	AUM1	ThinkSystem 2.5" 1.2TB 10K SAS 12Gb Hot Swap 512n HDD	48
7XB7A00028	AUM2	ThinkSystem 2.5" 1.8TB 10K SAS 12Gb Hot Swap 512e HDD	48
7XB7A00069	B0YS	ThinkSystem 2.5" 2.4TB 10K SAS 12Gb Hot Swap 512e HDD	48
2.5-inch hot-sv	wap HDDs	- 12 Gb SAS 15K	•
7XB7A00021	AULV	ThinkSystem 2.5" 300GB 15K SAS 12Gb Hot Swap 512n HDD	48
7XB7A00022	AULW	ThinkSystem 2.5" 600GB 15K SAS 12Gb Hot Swap 512n HDD	48
7XB7A00023	AULX	ThinkSystem 2.5" 900GB 15K SAS 12Gb Hot Swap 512e HDD	48
2.5-inch hot-sv	wap HDDs	- 12 Gb NL SAS	
7XB7A00034	AUM6	ThinkSystem 2.5" 1TB 7.2K SAS 12Gb Hot Swap 512n HDD	48
7XB7A00035	AUM7	ThinkSystem 2.5" 2TB 7.2K SAS 12Gb Hot Swap 512n HDD	48
2.5-inch hot-sv	wap SED H	IDDs - 12 Gb SAS 10K	
7XB7A00031	AUM5	ThinkSystem 2.5" 600GB 10K SAS 12Gb Hot Swap 512n HDD SED	48
7XB7A00033	B0YX	ThinkSystem 2.5" 1.2TB 10K SAS 12Gb Hot Swap 512n HDD SED	48
7XB7A00070	B0YV	ThinkSystem 2.5" 2.4TB 10K SAS 12Gb Hot Swap 512e HDD FIPS	48

Table 23. 2.5-inch hot-swap 6 Gb SATA HDDs

Part number	Feature	Description	Maximum supported
2.5-inch hot-swap HDDs - 6 Gb NL SATA			
7XB7A00036	AUUE	ThinkSystem 2.5" 1TB 7.2K SATA 6Gb Hot Swap 512n HDD	48
7XB7A00037	AUUJ	ThinkSystem 2.5" 2TB 7.2K SATA 6Gb Hot Swap 512e HDD	48

Table 24. 2.5-inch hot-swap 12 Gb SAS SSDs

Part number	Feature	Description	Maximum supported	
2.5-inch hot-swap SSDs - 12 Gb SAS - Write Intensive/Performance (10+ DWPD)				
4XB7A70006	BG07	ThinkSystem 2.5" Nytro 3732 400GB Performance SAS 12Gb Hot Swap SSD	48	
4XB7A70005	BG06	ThinkSystem 2.5" Nytro 3732 800GB Performance SAS 12Gb Hot Swap SSD	48	
4XB7A70004	BG05	ThinkSystem 2.5" Nytro 3732 1.6TB Performance SAS 12Gb Hot Swap SSD	48	
4XB7A70003	BG04	ThinkSystem 2.5" Nytro 3732 3.2TB Performance SAS 12Gb Hot Swap SSD	48	
2.5-inch hot-sv	wap SSDs	- 12 Gb SAS - Mixed Use/Mainstream (3-5 DWPD)		
4XB7A17062	B8HU	ThinkSystem 2.5" PM1645a 800GB Mainstream SAS 12Gb Hot Swap SSD	48	
4XB7A17063	B8J4	ThinkSystem 2.5" PM1645a 1.6TB Mainstream SAS 12Gb Hot Swap SSD	48	
4XB7A17064	B8JD	ThinkSystem 2.5" PM1645a 3.2TB Mainstream SAS 12Gb Hot Swap SSD	48	
4XB7A17065	B8JA	ThinkSystem 2.5" PM1645a 6.4TB Mainstream SAS 12Gb Hot Swap SSD	48	
2.5-inch hot-swap SSDs - 12 Gb SAS - Read Intensive/Entry/Capacity (<3 DWPD)				
4XB7A38175	B91A	ThinkSystem 2.5" PM1643a 960GB Entry SAS 12Gb Hot Swap SSD	48	
4XB7A38176	B91B	ThinkSystem 2.5" PM1643a 1.92TB Entry SAS 12Gb Hot Swap SSD	48	
4XB7A17054	B91C	ThinkSystem 2.5" PM1643a 3.84TB Entry SAS 12Gb Hot Swap SSD	48	
4XB7A17055	B91D	ThinkSystem 2.5" PM1643a 7.68TB Entry SAS 12Gb Hot Swap SSD	48	
4XB7A17056	BC4R	ThinkSystem 2.5" PM1643a 15.36TB Entry SAS 12Gb Hot Swap SSD	48	
2.5-inch hot-sv	2.5-inch hot-swap SED SSDs - 12 Gb SAS - Write Intensive/Performance (10+ DWPD)			
4XB7A70007	BFZZ	ThinkSystem 2.5" Nytro 3732 800GB Performance SAS 12Gb Hot Swap SSD SED	48	

Table 25. 2.5-inch hot-swap 6 Gb SATA SSDs

Part number	Foaturo	Description	Maximum supported
		- 6 Gb SATA - Mixed Use/Mainstream (3-5 DWPD)	supported
4XB7A17125	•	ThinkSystem 2.5" S4620 480GB Mixed Use SATA 6Gb HS SSD	48
4XB7A17126	BA4T	ThinkSystem 2.5" S4620 960GB Mixed Use SATA 6Gb HS SSD	48
4XB7A17127	BA4U	ThinkSystem 2.5" S4620 1.92TB Mixed Use SATA 6Gb HS SSD	48
4XB7A17128	BK7L	ThinkSystem 2.5" S4620 3.84TB Mixed Use SATA 6Gb HS SSD	48
4XB7A17087	B8J1	ThinkSystem 2.5" 5300 240GB Mainstream SATA 6Gb Hot Swap SSD	48
4XB7A17088	B8HY	ThinkSystem 2.5" 5300 480GB Mainstream SATA 6Gb Hot Swap SSD	48
4XB7A17089	B8J6	ThinkSystem 2.5" 5300 960GB Mainstream SATA 6Gb Hot Swap SSD	48
4XB7A17009	B8JE	ThinkSystem 2.5" 5300 1.92TB Mainstream SATA 6Gb Hot Swap SSD	48
4XB7A17090 4XB7A17091	B8J7	ThinkSystem 2.5" 5300 3.84TB Mainstream SATA 6Gb Hot Swap SSD	48
4XB7A17691	B49L	ThinkSystem 2.5" S4610 240GB Mixed Use SATA 6Gb HS SSD	48
4XB7A13634	B49M	ThinkSystem 2.5" S4610 480GB Mixed Use SATA 6Gb HS SSD	48
4XB7A13635	B49N	ThinkSystem 2.5" S4610 960GB Mixed Use SATA 6Gb HS SSD	48
4XB7A13636	B49P	ThinkSystem 2.5" S4610 1.92TB Mixed Use SATA 6Gb HS SSD	48
4XB7A13637	B49P	ThinkSystem 2.5" S4610 3.84TB Mixed Use SATA 6Gb HS SSD	48
4XB7A13638	BB9R	ThinkSystem 2.5" S4610 7.68TB Mixed Use SATA 6Gb HS SSD	48
		- 6 Gb SATA - Read Intensive/Entry (<3 DWPD)	40
4XB7A17072	B99D	ThinkSystem 2.5" S4520 240GB Read Intensive SATA 6Gb HS SSD	48
4XB7A17101	BA7G	ThinkSystem 2.5" S4520 480GB Read Intensive SATA 6Gb HS SSD	48
4XB7A17102	BA7H	ThinkSystem 2.5" S4520 960GB Read Intensive SATA 6Gb HS SSD	48
4XB7A17103	BA7J	ThinkSystem 2.5" S4520 1.92TB Read Intensive SATA 6Gb HS SSD	48
4XB7A17104	BK77	ThinkSystem 2.5" S4520 3.84TB Read Intensive SATA 6Gb HS SSD	48
4XB7A17105	BK78	ThinkSystem 2.5" S4520 7.68TB Read Intensive SATA 6Gb HS SSD	48
4XB7A17075	B8HV	ThinkSystem 2.5" 5300 240GB Entry SATA 6Gb Hot Swap SSD	48
4XB7A17076	B8JM	ThinkSystem 2.5" 5300 480GB Entry SATA 6Gb Hot Swap SSD	48
4XB7A17077	В8НР	ThinkSystem 2.5" 5300 960GB Entry SATA 6Gb Hot Swap SSD	48
4XB7A17078	B8J5	ThinkSystem 2.5" 5300 1.92TB Entry SATA 6Gb Hot Swap SSD	48
4XB7A17079	B8JP	ThinkSystem 2.5" 5300 3.84TB Entry SATA 6Gb Hot Swap SSD	48
4XB7A17080	B8J2	ThinkSystem 2.5" 5300 7.68TB Entry SATA 6Gb Hot Swap SSD	48
4XB7A10247	B498	ThinkSystem 2.5" S4510 240GB Read Intensive SATA 6Gb HS SSD	48
4XB7A10248	B499	ThinkSystem 2.5" S4510 480GB Read Intensive SATA 6Gb HS SSD	48
4XB7A10249	B49A	ThinkSystem 2.5" S4510 960GB Read Intensive SATA 6Gb HS SSD	48
4XB7A13622	B49B	ThinkSystem 2.5" S4510 1.92TB Read Intensive SATA 6Gb HS SSD	48
4XB7A13623	B49C	ThinkSystem 2.5" S4510 3.84TB Read Intensive SATA 6Gb HS SSD	48
4XB7A13624	B96X	ThinkSystem 2.5" S4510 7.68TB Read Intensive SATA 6Gb HS SSD	48

Table 26. 2.5-inch hot-swap PCIe 4.0 NVMe SSDs (operate at PCIe 3.0 speeds in this server)

Part number	Feature	Description	Maximum supported
2.5-inch SSDs	- U.2 PCI	4.0 NVMe - Mixed Use/Mainstream (3-5 DWPD)	
4XB7A17152	BCFV	ThinkSystem 2.5" U.2 P5600 1.6TB Mixed Use NVMe PCle 4.0 x4 HS SSD	24
4XB7A17153	BCFR	ThinkSystem 2.5" U.2 P5600 3.2TB Mixed Use NVMe PCle 4.0 x4 HS SSD	24
4XB7A17154	BCFS	ThinkSystem 2.5" U.2 P5600 6.4TB Mixed Use NVMe PCle 4.0 x4 HS SSD	24
2.5-inch SSDs	- U.3 PCI	4.0 NVMe - Mixed Use/Mainstream (3-5 DWPD)	
4XB7A64175	BE03	ThinkSystem U.3 Kioxia CM6-V 800GB Mainstream NVMe PCIe 4.0 x4 Hot Swap SSD	24
4XB7A17112	B96Z	ThinkSystem U.3 Kioxia CM6-V 1.6TB Mainstream NVMe PCle4.0 x4 Hot Swap SSD	24
4XB7A17113	B96T	ThinkSystem U.3 Kioxia CM6-V 3.2TB Mainstream NVMe PCle4.0 x4 Hot Swap SSD	24
4XB7A17114	B96P	ThinkSystem U.3 Kioxia CM6-V 6.4TB Mainstream NVMe PCle4.0 x4 Hot Swap SSD	24
2.5-inch SSDs	- U.2 PCI	e 4.0 NVMe - Read Intensive/Entry (<3 DWPD)	
4XB7A17145	BCFT	ThinkSystem 2.5" U.2 P5500 1.92TB Read Intensive NVMe PCle 4.0 x4 HS SSD	24
4XB7A17146	BCFW	ThinkSystem 2.5" U.2 P5500 3.84TB Read Intensive NVMe PCle 4.0 x4 HS SSD	24
4XB7A17147	BCFU	ThinkSystem 2.5" U.2 P5500 7.68TB Read Intensive NVMe PCIe 4.0 x4 HS SSD	24

Table 27. 2.5-inch hot-swap PCIe 3.0 NVMe SSDs

Part number	Feature	Description	Maximum supported	
2.5-inch SSDs - U.2 PCle 3.0 NVMe - Write Intensive/Performance (10+ DWPD)				
4XB7A38159	B972	ThinkSystem 2.5" U.2 P4800X 375GB Write Intensive NVMe PCle 3.0 x4 HS SSD 60DWPD	24	
4XB7A38160	B973	ThinkSystem 2.5" U.2 P4800X 750GB Write Intensive NVMe PCle 3.0 x4 HS SSD 60DWPD	24	
4XB7A17163	B96L	ThinkSystem 2.5" U.2 P4800X 1.5TB Write Intensive NVMe PCIe 3.0 x4 HS SSD 60DWPD	24	
2.5-inch SSDs	- U.2 PCI	e 3.0 NVMe - Read Intensive/Entry (<3 DWPD)		
4XB7A10204	B58G	ThinkSystem 2.5" U.2 P4510 2.0TB Read Intensive NVMe PCle 3.0 x4 HS SSD	24	
4XB7A10175	B34N	ThinkSystem U.2 PM983 1.92TB Entry NVMe PCIe 3.0 x4 Hot Swap SSD	24	
4XB7A10176	B34P	ThinkSystem U.2 PM983 3.84TB Entry NVMe PCIe 3.0 x4 Hot Swap SSD	24	
4XB7A10177	B4D3	ThinkSystem U.2 PM983 7.68TB Entry NVMe PCle3.0 x4 Hot Swap SSD	24	

Note: NVMe PCIe SSDs support surprise hot removal and hot insertion, provided the operating system supports PCIe SSD hot-swap.

Table 28. 7mm 2.5-inch hot-swap 6 Gb SATA SSDs

Part number	Feature	Description	Maximum supported		
7mm 2.5-inch	7mm 2.5-inch hot-swap SSDs - 6 Gb SATA - Read Intensive/Entry (<3 DWPD)				
4XB7A17106	BK79	ThinkSystem 7mm S4520 240GB Read Intensive SATA 6Gb HS SSD	2		
4XB7A17107	BK7A	ThinkSystem 7mm S4520 480GB Read Intensive SATA 6Gb HS SSD	2		
4XB7A17108	BK7B	ThinkSystem 7mm S4520 960GB Read Intensive SATA 6Gb HS SSD	2		
4XB7A38181	B8JQ	ThinkSystem 7mm 5300 240GB Entry SATA 6Gb SSD	2		
4XB7A38182	B8JT	ThinkSystem 7mm 5300 480GB Entry SATA 6Gb SSD	2		
4XB7A38183	B8JS	ThinkSystem 7mm 5300 960GB Entry SATA 6Gb SSD	2		
4XB7A38152	B96Q	ThinkSystem 7mm S4510 240GB Read Intensive SATA 6Gb HS SSD	2		
4XB7A38153	B96S	ThinkSystem 7mm S4510 480GB Read Intensive SATA 6Gb HS SSD	2		
4XB7A38154	B96R	ThinkSystem 7mm S4510 960GB Read Intensive SATA 6Gb HS SSD	2		

Table 29. 7mm 2.5-inch hot-swap PCIe 3.0 NVMe SSDs

Part number	Feature	Description	Maximum supported		
7mm 2.5-inch	7mm 2.5-inch hot-swap SSDs - PCIe 3.0 NVMe - Read Intensive/Entry (<3 DWPD)				
4XB7A38216	BB63	ThinkSystem 7mm PM983 960GB Entry NVMe PCIe 3.0 x4 Hot Swap SSD	2		

Note: NVMe PCIe SSDs support surprise hot removal and hot insertion, provided the operating system supports PCIe SSD hot-swap.

Table 30. M.2 SATA drives

Part number	Feature	Description	Maximum supported			
M.2 SSDs - 6	M.2 SSDs - 6 Gb SATA - Read Intensive/Entry (<3 DWPD)					
7N47A00129	AUUL	ThinkSystem M.2 32GB SATA 6Gbps Non-Hot Swap SSD	2			
7N47A00130	AUUV	ThinkSystem M.2 128GB SATA 6Gbps Non-Hot Swap SSD	2			
4XB7A17071	B8HS	ThinkSystem M.2 5300 240GB SATA 6Gbps Non-Hot Swap SSD	2			
4XB7A17073	B919	ThinkSystem M.2 5300 480GB SATA 6Gbps Non-Hot Swap SSD	2			
4XB7A17074	B8JJ	ThinkSystem M.2 5300 960GB SATA 6Gbps Non-Hot Swap SSD	2			

Table 31. M.2 NVMe drives

Part number	Feature	Description	Maximum supported		
M.2 SSDs - N	M.2 SSDs - NVMe - Read Intensive/Entry (<3 DWPD)				
4XB7A38177	B8JR	ThinkSystem M.2 PM983 960GB NVMe PCle 3.0 x4 Non-Hot Swap SSD	2		

Internal backup units

The server does not support any internal backup units, such as tape drives or RDX drives.

Optical drives

The server does not support an internal optical drive.

An external USB optical drive is available, listed in the following table.

Table 32. External optical drive

Part number	Feature code	Description
7XA7A05926	AVV8	ThinkSystem External USB DVD RW Optical Disk Drive

I/O expansion options

The SR860 V2 has up to 14 PCIe 3.0 slots plus an OCP 3.0 slot reserved for an Ethernet adapter.

The following figure shows the locations of the PCIe slots.

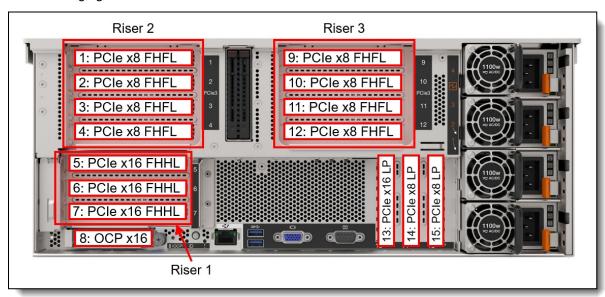


Figure 12. SR860 V2 slot numbering

Physically x16 slots: Many of the x8 slots in the server have a physical x16 connector. This means that the slot mechanically accepts an adapter that has the longer x16 edge connector. However since the slot is electrically x8, it only has eight PCIe lanes for data transfer and only has the performance of a x8 slot. If a x8 slot is physically x8, that means a x16 cannot physically be installed in the slot.

The slots are grouped on risers or directly on the system planar, as shown in the figure:

- Riser 2 (x32 riser connection to Expansion Tray):
 - Slot 1: PCle x8 FHFL (physically x16) (not present if slot 2 is PCle x16) (connects to CPU 4)
 - Slot 2: PCIe x8 FHFL (physically x16) or PCIe x16 FHFL double-wide (CPU 4)
 - Slot 3: PCle x8 FHFL (physically x16) (not present if slot 4 is PCle x16) (CPU 4)
 - Slot 4: PCle x8 FHFL (physically x16) or PCle x16 FHFL double-wide (CPU 4)
- Riser 1 (x16 riser slot on system planar with two additional x16 cabled connections):
 - Slot 5: PCle x16 FHHL (CPU 2) or PCle x8 FHHL with 2-slot riser (CPU 2)
 - Slot 6: PCle x16 FHHL (CPU 1) or PCle x8 FHHL with 2-slot riser (CPU 1)
 - Slot 7: PCle x16 FHHL (not present if 2-slot riser is selected) (CPU 2)*
- Slot 8: OCP 3.0 slot with PCIe x16 connection (CPU 2)
- Riser 3 (x32 riser connection to Expansion Tray):

- Slot 9: PCle x8 FHFL (physically x16) (not present if slot 10 is PCle x16) (CPU 3)
- Slot 10: PCIe x8 FHFL (physically x16) or PCIe x16 FHFL double-wide (CPU 3)
- Slot 11: PCle x8 FHFL (physically x16) (not present if slot 12 is PCle x16) (CPU 3)
- Slot 12: PCIe x8 FHFL (physically x16) or PCIe x16 FHFL double-wide (CPU 3)
- System planar slots:
 - Slot 13: PCIe x16 LP (CPU 1)
 - Slot 14: PCle x8 LP (physically x8) (CPU 1)
 - Slot 15: PCIe x8 LP (physically x8) (CPU 1)

Riser 2 and Riser 3 support two different riser card selections:

- 4x PCIe 3.0 x8 slots (physically x16) supporting single-wide GPUs and other FHFL adapters Feature code BAW9
- 2x PCIe 3.0 x16 slots supporting double-wide GPUs and other FHFL adapters Feature code BAW8

Riser 1 supports two different riser card selections:

- 3x PCIe 3.0 x16 slots, slots 5, 6, & 7, supporting FHHL adapters Feature code BAW7. The connections of these slots is shown in the System architecture section:
 - Slot 5 connects to CPU 2 via the riser slot
 - Slot 6 connects to CPU 1 via a cable to a connector on the system board
 - Slot 7 connects to CPU 2 via a cable to a connector on the system board

Note: The use of this riser precludes the use of 8 onboard NVMe drive connections, since they use the same connectors.

- 2x PCle 3.0 x8 slots (physically x16), slots 5 & 6, supporting FHHL adapters Feature code BAW6.
 - Slot 5 connects to CPU 2 via the riser slot
 - Slot 6 connects to CPU 2 via the riser slot

Note: This riser still permits the use of the 8 onboard NVMe drive connections that the 3-slot riser consumes.

The riser cards supported are listed in the following table.

Table 33. Riser cards for SR860 V2

Part number	Feature code	Description				
Risers for Slots 1-	Risers for Slots 1-4 and Slots 9-12					
4C57A15006	BAW9	ThinkSystem SR860 V2 x8/x8/x8/x8 PCIe FH Riser 2/3				
4C57A15005	BAW8	ThinkSystem SR860 V2 x16/x16 PCIe FH Riser 2/3 (supports double-wide GPUs)				
Risers for Slots 5-	-7					
4C57A15004	BAW7	ThinkSystem SR850/SR860 V2 x16/x16/x16 PCle FH Riser 1				
4C57A15003	BAW6	ThinkSystem SR850/SR860 V2 x8/x8 PCIe FH Riser 1				

Network adapters

The server has a dedicated OCP 3.0 SFF slot with PCle 3.0 x16 host interface. See Figure 3 for the location of the OCP slot.

The following table lists the supported OCP adapters. One port can optionally be shared with the XCC management processor for Wake-on-LAN and NC-SI support. Only one OCP card can be installed in the server.

Table 34. OCP adapters

Part number	Feature code	Description	Maximum supported				
Gigabit Ethern	Gigabit Ethernet						
4XC7A08235	B5T1	ThinkSystem Broadcom 5719 1GbE RJ45 4-port OCP Ethernet Adapter	1				
4XC7A08277	B93E	ThinkSystem Intel I350 1GbE RJ45 4-port OCP Ethernet Adapter	1				
Combination 1	Gb and 10G	b Ethernet					
4XC7A08239	B5SS	ThinkSystem Broadcom 57416 10GBASE-T 2-port + 5720 1GbE 2-port OCP Ethernet Adapter	1				
10Gb Etherne	t						
4XC7A08236	B5ST	ThinkSystem Broadcom 57416 10GBASE-T 2-port OCP Ethernet Adapter	1				
4XC7A08240	B5T4	ThinkSystem Broadcom 57454 10GBASE-T 4-port OCP Ethernet Adapter					
4XC7A08278	BCD5	ThinkSystem Intel X710-T2L 10GBASE-T 2-port OCP Ethernet Adapter					
4XC7A08310	BB8U	ThinkSystem Marvell QL41132 10GBASE-T 2-port OCP Ethernet Adapter					
25Gb Etherne	t						
4XC7A08242	B5SV	ThinkSystem Broadcom 57454 10/25GbE SFP28 4-port OCP Ethernet Adapter	1				
4XC7A08294	BCD4	ThinkSystem Intel E810-DA2 10/25GbE SFP28 2-Port OCP Ethernet Adapter	1				
4XC7A08264	B5SW	ThinkSystem Marvell QL41232 10/25GbE SFP28 2-Port OCP Ethernet Adapter	1				
4XC7A62582	BE4T	ThinkSystem Mellanox ConnectX-6 Lx 10/25GbE SFP28 2-Port OCP Ethernet Adapter	1				

The following table lists additional supported network adapters that can be installed in the regular PCIe slots.

Table 35. PCIe network adapters

Part number	Feature code	Description	Maximum supported	Slots supported
Gigabit Ethern	et			
7ZT7A00484	AUZV	ThinkSystem Broadcom 5719 1GbE RJ45 4-Port PCIe Ethernet Adapter	14	Any slots
7ZT7A00482	AUZX	ThinkSystem Broadcom 5720 1GbE RJ45 2-Port PCIe Ethernet Adapter	14	Any slots
7ZT7A00533	AUZZ	ThinkSystem I350-F1 PCIe 1Gb 1-Port SFP Ethernet Adapter	14	Any slots
7ZT7A00534	AUZY	ThinkSystem I350-T2 PCIe 1Gb 2-Port RJ45 Ethernet Adapter	14	Any slots
7ZT7A00535	AUZW	ThinkSystem I350-T4 PCIe 1Gb 4-Port RJ45 Ethernet Adapter	14	Any slots
10Gb Etherne	t			
7ZT7A00496	AUKP	ThinkSystem Broadcom 57416 10GBASE-T 2-Port PCIe Ethernet Adapter	14	Any slots
4XC7A08245	BFY6	ThinkSystem Broadcom 57454 10GBASE-T 4-port PCIe Ethernet Adapter	14	Any slots
00MM860	ATPX	Intel X550-T2 Dual Port 10GBase-T Adapter	14	Any slots

Part number	Feature code	Description	Maximum supported	Slots supported
7ZT7A00537	AUKX	ThinkSystem Intel X710-DA2 PCIe 10Gb 2-Port SFP+ Ethernet Adapter	14	Any slots
4XC7A08225	B31G	ThinkSystem QLogic QL41134 PCle 10Gb 4-Port Base-T Ethernet Adapter	14	Any slots
25Gb Etherne	t			
4XC7A08238	B5T0	ThinkSystem Broadcom 57414 10/25GbE SFP28 2-port PCle Ethernet Adapter	14	Any slots
4XC7A08316	BD49	ThinkSystem Broadcom 57454 10/25GbE SFP28 4-port PCle Ethernet Adapter V2	13	Not slot 13
4XC7A08295	BCD6	ThinkSystem Intel E810-DA2 10/25GbE SFP28 2-Port PCIe Ethernet Adapter	14	Any slots
4XC7A08270	B652	ThinkSystem Marvell QL41232 10/25GbE SFP28 2-Port PCle Ethernet Adapter	14	Any slots
4XC7A62580	BE4U	ThinkSystem Mellanox ConnectX-6 Lx 10/25GbE SFP28 2- Port PCIe Ethernet Adapter	14	Any slots
100Gb Ethern	et and HD	PR100 InfiniBand		
4XC7A08297	B96F	ThinkSystem Broadcom 57508 100GbE QSFP56 2-port PCle 4 Ethernet Adapter	5	2,4,5,10,12
4XC7A08248	B8PP	ThinkSystem Mellanox ConnectX-6 Dx 100GbE QSFP56 2-port PCle Ethernet Adapter	5	2,4,5,10,12
4C57A14177	B4R9	ThinkSystem Mellanox ConnectX-6 HDR100/100GbE QSFP56 1-port PCle VPI Adapter	5	2,4,5,10,12
4C57A14178	B4RA	ThinkSystem Mellanox ConnectX-6 HDR100/100GbE QSFP56 2-port PCle VPI Adapter	5	2,4,5,10,12
200Gb Ethern	et and HD	R InfiniBand		
4C57A15326	B4RC	ThinkSystem Mellanox ConnectX-6 HDR/200GbE QSFP56 1-port PCIe 4 VPI Adapter	3	2,5,10
4C57A14179	B4RB	ThinkSystem Mellanox HDR/200GbE 2x PCle Aux Kit	3	6,4,12

For details about these adapters, see the relevant product guide:

- Ethernet adapters: https://lenovopress.com/servers/options/ethernet
- InfiniBand adapters: https://lenovopress.com/servers/options/infiniband

Fibre Channel host bus adapters

The following table lists the Fibre Channel HBAs supported by the server.

Table 36. Fibre Channel HBAs

Part number	Feature code	Description	Maximum supported	Slots supported			
64Gb Fibre Ch	34Gb Fibre Channel						
4XC7A77485	BLC1	ThinkSystem Emulex LPe36002 64Gb 2-port PCle Fibre Channel Adapter	14	Any slots			
32Gb Fibre Ch	nannel						
4XC7A08250	B5SX	ThinkSystem Emulex LPe35000 32Gb 1-port PCle Fibre Channel Adapter	14	Any slots			
4XC7A08251	B5SY	ThinkSystem Emulex LPe35002 32Gb 2-port PCle Fibre Channel Adapter	14	Any slots			
4XC7A08279	BA1G	ThinkSystem QLogic QLE2770 32Gb 1-Port PCIe Fibre Channel Adapter	14	Any slots			
4XC7A08276	BA1F	ThinkSystem QLogic QLE2772 32Gb 2-Port PCle Fibre Channel Adapter	14	Any slots			
16Gb Fibre Ch	nannel						
01CV830	ATZU	Emulex 16Gb Gen6 FC Single-port HBA	14	Any slots			
01CV840	ATZV	Emulex 16Gb Gen6 FC Dual-port HBA	14	Any slots			
01CV750	ATZB	QLogic 16Gb Enhanced Gen5 FC Single-port HBA	14	Any slots			
01CV760	ATZC	QLogic 16Gb Enhanced Gen5 FC Dual-port HBA	14	Any slots			

For more information, see the list of Lenovo Press Product Guides in the Host bus adapters category: https://lenovopress.com/servers/options/hba

SAS adapters for external storage

The following table lists SAS HBAs and RAID adapters supported by the server for use with external storage.

Table 37. Adapters for external storage

Part number	Feature code	Description	Maximum supported	Slots supported	
SAS HBAs					
7Y37A01090	AUNR	ThinkSystem 430-8e SAS/SATA 12Gb HBA	14	Any slots	
7Y37A01091	AUNN	ThinkSystem 430-16e SAS/SATA 12Gb HBA	14	Any slots	
External RAID adapters					
7Y37A01087	AUNQ	ThinkSystem RAID 930-8e 4GB Flash PCle 12Gb Adapter	4	Any slots	

The RAID 930-8e, like other RAID 930 and RAID 940 adapters, uses a flash power module (supercap) and the server supports up to four supercaps. The number of 930-8e RAID adapters supported is based on how many supercaps can be installed in the server. For example, if your configuration uses two RAID 930/940 adapters for internal storage, then you can only install two RAID 930-8e adapters, since there is only space for four supercaps total.

For details about these adapters, see the relevant product guide:

- SAS HBAs: https://lenovopress.com/servers/options/hba
- RAID adapters: https://lenovopress.com/servers/options/raid

The following table compares the specifications of the external SAS HBAs and RAID adapters.

Table 38. Comparison of external storage adapters

Feature	430-8e	430-16e	930-8e
Adapter type	HBA	HBA	External RAID
Part number	7Y37A01090	7Y37A01091	7Y37A01087
Controller chip	LSI SAS3408	LSI SAS3416	LSI SAS3516
Broadcom equivalent	HBA 9400-8e	HBA 9400-16e	MegaRAID 9480-8e
Host interface	PCIe 3.0x8	PCle 3.0x8	PCIe 3.0x8
Port interface	12 Gb SAS	12 Gb SAS	12 Gb SAS
Number of ports	8	16	8
Port connectors	2x Mini-SAS HD SFF8644	4x Mini-SAS HD SFF8644	2x Mini-SAS HD SFF8644
Drive interface	SAS/SATA	SAS/SATA	SAS,SATA
Drive type	HDD/SSD/SED*	HDD/SSD/SED*	HDD,SED,SSD
Hot-swap drives	Yes	Yes	Yes
Maximum devices	1024	1024	216
RAID levels	None	None	0/1/10/5/50/6/60
JBOD mode	Yes	Yes	Yes
Cache	None	None	4GB (Standard)
CacheVault cache protection	None	None	Yes (Flash)
Performance Accelerator (FastPath)	No	No	Yes
SSD Caching (CacheCade Pro 2.0)	No	No	No
SED support*	Yes	Yes	Yes

^{*} SAS HBAs support SEDs (self-encrypting drives) by using software on the server and simply passing SED commands through the HBA to the drives. SED support by RAID controllers is provided using the built-in MegaRAID SafeStore functionality of the adapter.

To compare these adapters, see the ThinkSystem RAID Adapter and HBA Comparison Reference: https://lenovopress.com/lp1288-thinksystem-raid-adapter-and-hba-reference#internal-or-external-ports=External

Flash storage adapters

The server supports the PCIe Flash Storage adapters listed in the following table.

Table 39. Flash Storage adapters

Part number	Feature code		Maximum supported	Slots supported
4XB7A14076	-	ThinkSystem HHHL PM1735 3.2TB Mainstream NVMe PCIe 4.0 x8 Flash Adapter	9	1, 2, 3, 4, 5, 9, 10, 11, 12

PCle 3.0 host interface: When installed in this server, the PM1735 adapter operates at PCle 3.0 speeds.

For details about these adapters, see the Lenovo Press product guides in the Flash Adapters category: https://lenovopress.com/servers/options/ssdadapter

GPU adapters

The SR860 V2 supports the graphics processing units (GPUs) listed in the following table:

Table 40. GPU adapters

Part number	Feature code	Description	Maximum supported	Slots supported
4X67A14926	B4YB	ThinkSystem NVIDIA T4 16GB PCIe Passive GPU	8	1, 2, 3, 4, 9, 10, 11, 12
4X67A13124	BB2E	ThinkSystem NVIDIA Tesla V100S 32GB PCIe Passive GPU	4	2, 4, 10, 12
4X67A13135	BEL5	ThinkSystem NVIDIA A100 40GB PCIe Gen4 Passive GPU	4	2, 4, 10, 12

For details about these GPUs, see the ThinkSystem and ThinkAgile GPU Summary: https://lenovopress.com/lp0768-thinksystem-thinkagile-gpu-summary

The following rules apply when using GPUs:

- Select the correct riser, as listed in the table below.
- · Installed GPUs must be identical

Table 41. Riser cards for GPUs

Part number	Feature code	Description	GPU support		
Risers for Slots	Risers for Slots 1-4 and Slots 9-12				
4C57A15005	BAW8	ThinkSystem SR860 V2 x16/x16 PCIe FH Riser 2/3	V100S, A100		
4C57A15006	BAW9	ThinkSystem SR860 V2 x8/x8/x8/x8 PCIe FH Riser 2/3	T4		

GPUs other than the NVIDIA T4 require an auxiliary power cable. For all other GPUs, the necessary auxiliary power cables are automatically selected as part of any factor (CTO) order. However when ordering these GPUs as field upgrades, you will need to also order the power cable separately. One part number is needed per GPU.

Note: The auxiliary power cable is not required for the NVIDIA T4 GPU

Table 42. Auxiliary power cable

Part number	Feature code	Description
4X97A76342	BAX5	GPU Riser to GPU Power Cable, 190mm

Cooling

The server has eight 60 mm hot-swap fans at the front of the server and all eight fans are standard in all models. The server offers N+1 redundancy, meaning that one fan can fail and the server still operates normally.

In addition, each of the two upper riser cages has two integrated dual-rotor fans. The pair of fans offer rotor redundancy - a riser cage can tolerate a single rotor failure and continue to operate.

Each power supply also includes an integrated fan.

The eight front fans are installed in a 4U-high unit as shown in the following figure. The eight fans are installed in six modules in vertical bays which comprise of either 1 fan or 2 fans, depending on the location of the bay:

- Fan modules 1, 3, 4 and 6: Contain 1 fan (bottom only; top bay remains open)
- Fan modules 2 and 5: Contain 2 fans

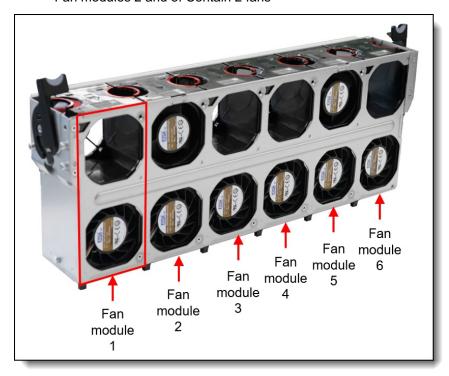


Figure 13. SR860 V2 front system fans

When servicing the fan modules, you remove the modules from the top of the unit (hot-swap). In the case of fan modules 2 and 5, two fans are removed at the same time. Although the server supports N+1 redundancy (that is, supporting the failure of 1 fan while maintaining server operation), the server supports the removal of two fans for the time it takes to undertake a fan replacement: remove the module, replace the fan, reinsert the module.

The server supports two types of fan modules:

- Standard fan modules: Bottom fan is a single-rotor fan, top fan is a dual-rotor fan
- Performance fan modules: Both bottom and top fans are dual-rotor fans

Fan module types cannot be mixed. All six modules must be either all standard fan modules, or all performance fan modules.

Performance fan modules are required for certain configurations:

- CPU > 165W TDP
- CPU suffix is HL (large memory support)
- 128GB or 256GB 3DS RDIMMs installed
- · Persistent Memory installed

The following table lists the CTO ordering information for the fan modules.

Table 43. Fan modules for CTO orders

Part number	Feature code	Description	Maximum supported
Standard fan modules			
CTO only	BAW2	Fan Slot 1/3/4/6 Standard	4
CTO only	BAW3	Fan Slot 2/5 Standard	2
Performance fan modules			
CTO only*	BAW0	Fan Slot 1/3/4/6 Performance	4
CTO only*	BAW1	Fan Slot 2/5 Performance	2

^{*} For field upgrades, see the next table

The server supports upgrading all standard fan modules to performance fan modules, using the kit listed in the following table.

Table 44. Fan module field upgrades

Part number	Feature code	Description	Maximum supported
4F17A14493	BDZU	ThinkSystem SR860 V2 Performance Fan Upgrade Kit • 4x Performance fan modules for bays 1, 3, 4 and 6 • 2x Performance fan modules for bays 2 and 5	1

Power supplies

The server supports up to four redundant hot-swap power supplies. Redundancy can be configured as N+1 or N+N.

Tip: Use Lenovo Capacity Planner to determine exactly what power your server needs: https://datacentersupport.lenovo.com/us/en/products/solutions-and-software/software/lenovo-capacity-planner/solutions/ht504651

Table 45. Power supply options for SR860 V2

Part number	Feature code	Description	Maximum supported	110V AC	220V AC	240V DC China only
4P57A26291	B8QA	ThinkSystem 750W(230/115V) v2 Platinum Hot-Swap Power Supply	4	Yes	Yes	Yes
4P57A26292	B8QD	ThinkSystem 750W (230V) v2 Titanium Hot-Swap Power Supply	4	No	Yes	Yes
4P57A26293	B8QC	ThinkSystem 1100W (230V/115V) v2 Platinum Hot-Swap Power Supply	4	Yes	Yes	Yes
4P57A26294	B8QB	ThinkSystem 1800W (230V) v2 Platinum Hot-Swap Power Supply	4	No	Yes	Yes

The 750W Platinum and 1100W power supplies are auto-sensing and support both 110V AC (100-127V 50/60 Hz) and 220V AC (200-240V 50/60 Hz) power. The 750 W Titanium and 1800 W power supplies only supports 220V AC power. For China customers, all power supplies support 240V DC.

Power supply options do not include a line cord. For server configurations, the inclusion of a power cord is model dependent. Configure-to-order models can be configured without a power cord if desired.

Power cords

Line cords and rack power cables with C13 connectors can be ordered as listed in the following table.

110V customers: If you plan to use the ThinkSystem 1100W power supply with a 110V power source, select a power cable that is rated above 10A. Power cables that are rated at 10A or below are not supported with 110V power.

Table 46. Power cords

Part number	Feature code	Description
Rack cables		
00Y3043	A4VP	1.0m, 10A/100-250V, C13 to C14 Jumper Cord
39Y7937	6201	1.5m, 10A/100-250V, C13 to C14 Jumper Cord
4L67A08369	6570	2.0m, 13A/100-250V, C13 to C14 Jumper Cord
4L67A08366	6311	2.8m, 10A/100-250V, C13 to C14 Jumper Cord
4L67A08370	6400	2.8m, 13A/100-250V, C13 to C14 Jumper Cord
39Y7932	6263	4.3m, 10A/100-250V, C13 to C14 Jumper Cord
4L67A08371	6583	4.3m, 13A/100-250V, C13 to C14 Jumper Cord
Line cords		
39Y7930	6222	2.8m, 10A/250V, C13 to IRAM 2073 (Argentina) Line Cord
81Y2384	6492	4.3m, 10A/250V, C13 to IRAM 2073 (Argentina) Line Cord
39Y7924	6211	2.8m, 10A/250V, C13 to AS/NZS 3112 (Australia/NZ) Line Cord
81Y2383	6574	4.3m, 10A/250V, C13 to AS/NZS 3112 (Australia/NZ) Line Cord
69Y1988	6532	2.8m, 10A/250V, C13 to NBR 14136 (Brazil) Line Cord
81Y2387	6404	4.3m, 10A/250V, C13 to NBR 14136 (Brazil) Line Cord
39Y7928	6210	2.8m, 10A/220V, C13 to GB 2099.1 (China) Line Cord
81Y2378	6580	4.3m, 10A/250V, C13 to GB 2099.1 (China) Line Cord
39Y7918	6213	2.8m, 10A/250V, C13 to DK2-5a (Denmark) Line Cord
81Y2382	6575	4.3m, 10A/250V, C13 to DK2-5a (Denmark) Line Cord
39Y7917	6212	2.8m, 10A/250V, C13 to CEE 7/7 (Europe) Line Cord
81Y2376	6572	4.3m, 10A/250V, C13 to CEE 7/7 (Europe) Line Cord
39Y7927	6269	2.8m, 10A/250V, C13 to IS 6538 (India) Line Cord
81Y2386	6567	4.3m, 10A/250V, C13 to IS 6538 (India) Line Cord
39Y7920	6218	2.8m, 10A/250V, C13 to SI 32 (Israel) Line Cord
81Y2381	6579	4.3m, 10A/250V, C13 to SI 32 (Israel) Line Cord
39Y7921	6217	2.8m, 10A/250V, C13 to CEI 23-16 (Italy) Line Cord
81Y2380	6493	4.3m, 10A/250V, C13 to CEI 23-16 (Italy) Line Cord
4L67A08362	6495	4.3m, 12A/200V, C13 to JIS C-8303 (Japan) Line Cord
39Y7922	6214	2.8m, 10A/250V, C13 to SABS 164-1 (South Africa) Line Cord
81Y2379	6576	4.3m, 10A/250V, C13 to SANS 164-1 (South Africa) Line Cord
39Y7926	6335	4.3m, 12A/100V, C13 to JIS C-8303 (Japan) Line Cord
39Y7925	6219	2.8m, 12A/220V, C13 to KSC 8305 (S. Korea) Line Cord
81Y2385	6494	4.3m, 12A/250V, C13 to KSC 8305 (S. Korea) Line Cord
39Y7919	6216	2.8m, 10A/250V, C13 to SEV 1011-S24507 (Swiss) Line Cord

Part number	Feature code	Description
81Y2390	6578	4.3m, 10A/250V, C13 to SEV 1011-S24507 (Swiss) Line Cord
23R7158	6386	2.8m, 10A/125V, C13 to CNS 10917 (Taiwan) Line Cord
81Y2375	6317	2.8m, 10A/250V, C13 to CNS 10917 (Taiwan) Line Cord
81Y2374	6402	2.8m, 13A/125V, C13 to CNS 10917 (Taiwan) Line Cord
4L67A08363	AX8B	4.3m, 10A/125V, C13 to CNS 10917 (Taiwan) Line Cord
81Y2389	6531	4.3m, 10A/250V, C13 to CNS 10917 (Taiwan) Line Cord
81Y2388	6530	4.3m, 13A/125V, C13 to CNS 10917 (Taiwan) Line Cord
39Y7923	6215	2.8m, 10A/250V, C13 to BS 1363/A (UK) Line Cord
81Y2377	6577	4.3m, 10A/250V, C13 to BS 1363/A (UK) Line Cord
90Y3016	6313	2.8M, 10A/125V, C13 to NEMA 5-15P (US) Line Cord
46M2592	A1RF	2.8m, 10A/250V, C13 to NEMA 6-15P (US) Line Cord
00WH545	6401	2.8M, 13A/125V, C13 to NEMA 5-15P (US) Line Cord
4L67A08359	6370	4.3m, 10A/125V, C13 to NEMA 5-15P (US) Line Cord
4L67A08361	6373	4.3m, 10A/250V, C13 to NEMA 6-15P (US) Line Cord
4L67A08360	AX8A	4.3m, 13A/125V, C13 to NEMA 5-15P (US) Line Cord

Systems management

The SR860 V2 contains an integrated service processor, XClarity Controller (XCC), which provides advanced control, monitoring, and alerting functions. The XCC is based on the Pilot4 XE401 baseboard management controller (BMC) using a dual-core ARM Cortex A9 service processor.

Topics in this section:

- Local management
- System status with XClarity Mobile
- Remote management
- Lenovo XClarity Provisioning Manager
- Lenovo XClarity Administrator
- Lenovo XClarity Essentials
- Lenovo XClarity Energy Manager
- Lenovo Capacity Planner

Local management

The server offers a front operator panel with key LED status indicators, as shown in the following figure.

Tip: The Network LED only shows network activity of the installed OCP network adapter.

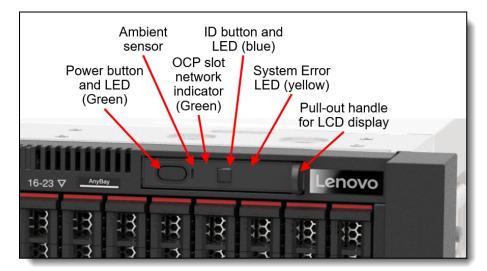


Figure 14. Front operator panel

The SR860 V2 includes an pull-out integrated diagnostics panel with LCD display (optional for customers in China, standard for all other markets) as shown in the following figure.



Figure 15. Integrated diagnostics panel with LCD display

The Integrated diagnostics panel allows quick access to system status, firmware, network, and health information. The LCD display on the panel and the function buttons give you access to the following information:

- Active alerts
- Status Dashboard
- System VPD: machine type & mode, serial number, UUID string
- System firmware levels: UEFI and XCC firmware
- XCC network information: hostname, MAC address, IP address, DNS addresses
- Environmental data: Ambient temperature, CPU temperature, AC input voltage, estimated power consumption
- Active XCC sessions
- System reset action

The front operator panel with LCD display can be ordered as listed in the following table.

Table 47. Ordering information for the front operator panel

Part number	Feature code	Description
CTO only*	BAVV	Front Operator Panel (without pull-out display; China only)
CTO only*	BAVU	Front Operator Panel with Quad Line LCD Display

^{*} Only available configure-to-order or with predefined models

Light path diagnostics

The server offers light path diagnostics. If an environmental condition exceeds a threshold or if a system component fails, XCC lights LEDs inside the server to help you diagnose the problem and find the failing part. The server has fault LEDs next to the following components:

- Each processor
- Each memory DIMM
- Each drive bay
- Each system fan
- Each power supply

A Light Path button is located on the system board, adjacent to Riser 1 as shown in the Internal view in the Components and connectors section. When you press this button, the LED associated with the failed component lights up. The button is attached to a supercap so that the LED lights up even if AC power is removed.

Information tab

The front of the server also houses an information pull-out tab (also known as the network access tag). See Figure 2 for the location. A label on the tab shows the network information (MAC address and other data) to remotely access XClarity Controller.

System status with XClarity Mobile

The XClarity Mobile app includes a tethering function where you can connect your Android or iOS device to the server via USB to see the status of the server.

The steps to connect the mobile device are as follows:

- 1. Enable USB Management on the server, by holding down the ID button for 3 seconds (or pressing the dedicated USB management button if one is present)
- 2. Connect the mobile device via a USB cable to the server's USB port with the management symbol
- 3. In iOS or Android settings, enable Personal Hotspot or USB Tethering
- 4. Launch the Lenovo XClarity Mobile app

Once connected you can see the following information:

- Server status including error logs (read only, no login required)
- Server management functions (XClarity login credentials required)

Remote management

The server offers a dedicated RJ45 port at the rear of the server for remote management via the XClarity Controller management processor. The port supports 10/100/1000 Mbps speeds.

Remote server management is provided through industry-standard interfaces:

- Intelligent Platform Management Interface (IPMI) Version 2.0
- Simple Network Management Protocol (SNMP) Version 3 (no SET commands; no SMNP v1)
- Common Information Model (CIM-XML)
- Representational State Transfer (REST) support
- Redfish support (DMTF compliant)
- Web browser HTML 5-based browser interface (Java and ActiveX not required) using a responsive design (content optimized for device being used - laptop, tablet, phone) with NLS support

IPMI via the Ethernet port (IPMI over LAN) is supported, however it is disabled by default. For CTO orders you can specify whether you want to the feature enabled or disabled in the factory, using the feature codes listed in the following table.

Table 48. IPMI-over-LAN settings

Part number	Feature code	Description
CTO only	B7XZ	Disable IPMI-over-LAN (default)
CTO only	B7Y0	Enable IPMI-over-LAN

The SR860 V2 has XCC Enterprise as a standard feature. XCC Enterprise includes a virtual presence (remote control and remote media) capability for remote server management.

The remote control functions include the following:

- Remotely viewing video with graphics resolutions up to 1600x1200 at 75 Hz with up to 23 bits per pixel, regardless of the system state
- Remotely accessing the server using the keyboard and mouse from a remote client
- · Capturing blue-screen errors
- International keyboard mapping support
- LDAP-based authentication
- Boot Capture
- · Remote mounting of ISO and IMG files
- Virtual console collaboration Ability for up to 6 remote users to be log into the remote session simultaneously
- · Power capping
- License for XClarity Energy Manager

Lenovo XClarity Administrator

Lenovo XClarity Administrator is a centralized resource management solution designed to reduce complexity, speed response, and enhance the availability of Lenovo systems and solutions.

Lenovo XClarity Administrator provides agent-free hardware management for ThinkSystem servers, in addition to ThinkServer, System x, and Flex System servers. The administration dashboard is based on HTML 5 and allows fast location of resources so tasks can be run quickly.

Because Lenovo XClarity Administrator does not require any agent software to be installed on the managed endpoints, there are no CPU cycles spent on agent execution, and no memory is used, which means that up to 1GB of RAM and 1 - 2% CPU usage is saved, compared to a typical managed system where an agent is required.

Lenovo XClarity Administrator provides full management function to ThinkSystem servers, including the following:

- Discovery
- Inventory
- · Monitoring and alerting
- Call home
- Centralized user management
- · Cryptography modes, server certificates, and encapsulation
- Configuration patterns
- Operating system deployment
- Firmware updates

For more information about Lenovo XClarity Administrator, including ordering part numbers, see the Lenovo XClarity Administrator Product Guide: https://lenovopress.com/tips1200-lenovo-xclarity-administrator

Lenovo XClarity Integrators

Lenovo also offers software plug-in modules, Lenovo XClarity Integrators, to manage physical infrastructure from leading external virtualization management software tools including those from Microsoft and VMware.

These integrators are offered at no charge, however if software support is required, a Lenovo XClarity Pro software subscription license should be ordered.

Lenovo XClarity Integrators offer the following additional features:

- Ability to discover, manage, and monitor Lenovo server hardware from VMware vCenter or Microsoft System Center
- Deployment of firmware updates and configuration patterns to Lenovo x86 rack servers and Flex System from the virtualization management tool
- Non-disruptive server maintenance in clustered environments that reduces workload downtime by dynamically migrating workloads from affected hosts during rolling server updates or reboots
- Greater service level uptime and assurance in clustered environments during unplanned hardware events by dynamically triggering workload migration from impacted hosts when impending hardware failures are predicted

For more information about all the available Lenovo XClarity Integrators, see the Lenovo XClarity Administrator Product Guide: https://lenovopress.com/tips1200-lenovo-xclarity-administrator

Lenovo XClarity Provisioning Manager

Lenovo XClarity Provisioning Manager (LXPM) is a UEFI-based application embedded in ThinkSystem servers and accessible via the F1 key during system boot.

LXPM provides the following functions:

- Graphical UEFI Setup
- System inventory information and VPD update
- System firmware updates (UEFI and XCC)
- · RAID setup wizard
- OS installation wizard (including unattended OS installation)
- Diagnostics functions

Lenovo XClarity Essentials

Lenovo offers the following XClarity Essentials software tools that can help you set up, use, and maintain the server at no additional cost:

Lenovo Essentials OneCLI

OneCLI is a collection of server management tools that uses a command line interface program to manage firmware, hardware, and operating systems. It provides functions to collect full system health information (including health status), configure system settings, and update system firmware and drivers.

Lenovo Essentials UpdateXpress

The UpdateXpress tool is a standalone GUI application for firmware and device driver updates that enables you to maintain your server firmware and device drivers up-to-date and help you avoid unnecessary server outages. The tool acquires and deploys individual updates and UpdateXpress System Packs (UXSPs) which are integration-tested bundles.

Lenovo Essentials Bootable Media Creator

The Bootable Media Creator (BOMC) tool is used to create bootable media for offline firmware update.

For more information and downloads, visit the Lenovo XClarity Essentials web page: http://support.lenovo.com/us/en/documents/LNVO-center

Lenovo XClarity Energy Manager

Lenovo XClarity Energy Manager is a power and temperature management solution for data centers. It is an agent-free, web-based console that enables you to monitor and manage power consumption and temperature in your data center through the management console. It enables server density and data center capacity to be increased through the use of power capping.

LXEM is a licensed product. A single-node LXEM license is included with the XClarity Controller Enterprise (XCC Enterprise) version. Because the Enterprise version of XCC is standard in the SR860 V2, a license for XClarity Energy Manager is included.

For more information about XClarity Energy Manager, see the following resources:

- Lenovo Support page: https://datacentersupport.lenovo.com/us/en/solutions/Invo-Ixem
- Lenovo Information Center: https://sysmgt.lenovofiles.com/help/topic/LXEM/lxem_overview.html?cp=4

Lenovo Capacity Planner

Lenovo Capacity Planner is a power consumption evaluation tool that enhances data center planning by enabling IT administrators and pre-sales professionals to understand various power characteristics of racks, servers, and other devices. Capacity Planner can dynamically calculate the power consumption, current, British Thermal Unit (BTU), and volt-ampere (VA) rating at the rack level, improving the planning efficiency for large scale deployments.

For more information, refer to the Capacity Planner web page: http://datacentersupport.lenovo.com/us/en/solutions/Invo-lcp

Security

The server offers the following electronic security features:

Administrator and power-on password

- Trusted Platform Module (TPM) supporting TPM 2.0 (TPM 1.2 not supported)
- Optional Nationz TPM 2.0, available only in China (CTO only)
- Self-encrypting drives with support for IBM Security Key Lifecycle Manager

The server is NIST SP 800-147B compliant.

The server also offers the following physical security features:

- Chassis intrusion switch (standard on some models, otherwise available as a field upgrade)
- Lockable top cover to help prevent access to internal components

The following table lists the security options for the server.

Table 49. Security features

Part number	Feature code	Description
4M27A11831	BAXC	ThinkSystem SR860 V2 Intrusion Switch Cable Kit
CTO only*	B8LE	ThinkSystem Nationz Trusted Platform Module v2.0 (China customers only)

^{*} The component is CTO on pre-configured models only. Not available as a field upgrade.

For SED drives and IBM Security Key Lifecycle Manager support see the SED encryption key management with ISKLM section.

Lenovo ThinkShield - Platform Firmware Resiliency

Lenovo's ThinkShield Security is a transparent and comprehensive approach to security that extends to all dimensions of our data center products: from development, to supply chain, and through the entire product lifecycle.

The ThinkSystem SR860 V2 offers Platform Firmware Resiliency (PFR) hardware Root of Trust (RoT) which is NIST SP800-193 compliant. This offering further enhances key platform subsystem protections against unauthorized firmware updates and corruption, to restore firmware to an integral state, and to closely monitor firmware for possible compromise from cyber attacks.

PFR operates upon the following server components:

- UEFI image the low level server firmware that connects the operating system to the server hardware
- XCC image the management "engine" software that controls and reports on the server status separate from the server operating system
- FPGA image the code that runs the server's lowest level hardware controller on the motherboard

The Lenovo Platform Root of Trust Hardware performs the following three main functions:

- Detection Measures the firmware and updates for authenticity
- Recovery Recovers a corrupted image to a known-safe image
- Protection Monitors the system to ensure the known-good firmware is not maliciously written

These enhanced protection capabilities are implemented using a dedicated, discrete security processor whose implementation has been rigorously validated by leading third-party security firms. Security evaluation results and design details are available for customer review – providing unprecedented transparency and assurance.

Intel Transparent Supply Chain

Add a layer of protection in your data center and have peace of mind that the server hardware you bring into it is safe authentic and with documented, testable, and provable origin.

Lenovo has one of the world's best supply chains, as ranked by Gartner Group, backed by extensive and mature supply chain security programs that exceed industry norms and US Government standards. Now we are the first Tier 1 manufacturer to offer Intel® Transparent Supply Chain in partnership with Intel, offering you an unprecedented degree of supply chain transparency and assurance.

To enable Intel Transparent Supply Chain for the Intel-based servers in your order, add the following feature code in the DCSC configurator, under the Security tab.

Table 50. Intel Transparent Supply Chain ordering information

Feature code	Description
BB0P	Intel Transparent Supply Chain

For more information on this offering, see the paper *Introduction to Intel Transparent Supply Chain on Lenovo ThinkSystem Servers*, available from https://lenovopress.com/lp1434-introduction-to-intel-transparent-supply-chain-on-thinksystem-servers.

Rack installation

The following table lists the rack installation options that are available for the server.

Table 51. Rack installation options

Option	Feature Code	Description
4XF7A12864	BDZT	ThinkSystem SR860 V2 2U Toolless Slide Rail
7M27A05698	AVBX	ThinkSystem 2U CMA Upgrade Kit for Toolless Slide Rail

The following table summarizes the rail kit features and specifications.

Table 52. Rail kit features and specifications summary

Feature	ThinkSystem SR860 V2 2U Toolless Slide Rail
Part number	4XF7A12864
Rail type	Full-out slide rail (ball bearing)
Toolless installation	Yes
Cable Management Arm (CMA) support	Optional (7M27A05698)
In-rack server maintenance	Yes
1U PDU support	Yes
0U PDU support	Limited*
Rack type	Four-post IBM and Lenovo standard rack, complying with the IEC standard
Mounting holes	Square (9.5mm), round (7.1mm)
Mounting flange thickness	2.0-3.3 mm (0.08 - 0.13 in.)
Distance between front and rear mounting flanges	610-813 mm (24-32 in.)
Rail length***	With CMA: 864 mm (34.0 in.) Without CMA: 784 mm (30.9 in.)
Rail travel length	850 mm (33.5 in.)

^{*} For 0U PDU support, the rack must be at least 1100 mm (43.31 in.) deep without the CMA, or at least 1200 mm (47.24 in.) deep if the CMA is used.

^{***} Measured when mounted on the rack, from the front surface of the front mounting flange to the rear most point of the rail.

Operating system support

The server supports the following operating systems:

- Microsoft Windows Server 2016
- Microsoft Windows Server 2019
- Microsoft Windows Server 2022
- Red Hat Enterprise Linux 7.9
- Red Hat Enterprise Linux 8.2
- Red Hat Enterprise Linux 8.3
- Red Hat Enterprise Linux 8.4
- SUSE Linux Enterprise Server 12 SP5
- SUSE Linux Enterprise Server 12 Xen SP5
- SUSE Linux Enterprise Server 15 SP2
- SUSE Linux Enterprise Server 15 SP3
- SUSE Linux Enterprise Server 15 Xen SP2
- SUSE Linux Enterprise Server 15 Xen SP3
- VMware ESXi 7.0 U1

Notes:

- VMware ESXi 7.0 U1 does not support Intel VROC. Only VMD is supported.
- RHEL 7.9 support initially limited to in-box drivers. Downloadable (out-of-box) drivers planned to be available 1Q/2021.
- ESXi 7.0 U1 support initially limited to in-box drivers for NVIDIA GPUs; and Mellanox ConnectX-6 HDR/HDR100 adapters will initially only be supported in Ethernet mode, not InfiniBand mode. Planned to be resolved in 1Q/2021.
- RHEL 7.9 will not initially support the Mellanox ConnectX-6 Lx adapters. Support planned 1Q/2021.

For a complete list of supported, certified and tested operating systems, plus additional details and links to relevant web sites, see the Operating System Interoperability Guide: https://lenovopress.com/osig#servers=sr860-v2-7z59-7z60

For configure-to-order configurations, the server can be preloaded with VMware ESXi installed. Ordering information is listed in the following table.

Table 53. VMware ESXi preload

Part number	Feature code	Description
CTO only	BE5E	VMware ESXi 7.0 U1 (Factory Installed)
CTO only	BHSR	VMware ESXi 7.0 U2 (Factory Installed)

Physical and electrical specifications

The SR860 V2 has the following overall physical dimensions, excluding components that extend outside the standard chassis, such as EIA flanges, front security bezel (if any), and power supply handles:

- Width: 447 mm (17.6 inches)Height: 175 mm (6.9 inches)
- Depth: 807 mm (31.8 inches)

The following table lists the detailed dimensions. See the figure below for the definition of each dimension.

Table 54. Detailed dimensions

Dimension	Description		
482 mm	X _a = Width, to the outsides of the front EIA flanges		
435 mm	X _b = Width, to the rack rail mating surfaces		
447 mm	X _c = Width, to the outer most chassis body feature		
175 mm	Ya = Height, from the bottom of chassis to the top of the chassis		
741 mm	Za = Depth, from the rack flange mating surface to the rearmost I/O port surface		
771 mm	Zb = Depth, from the rack flange mating surface to the rearmost feature of the chassis body		
798 mm	Zc = Depth, from the rack flange mating surface to the power supply handle		
36 mm	Zd = Depth, from the forwardmost feature on front of EIA flange to the rack flange mating surface		
36 mm	Ze = Depth, from the front of security bezel (if applicable) or forwardmost feature to the rack flange mating surface		

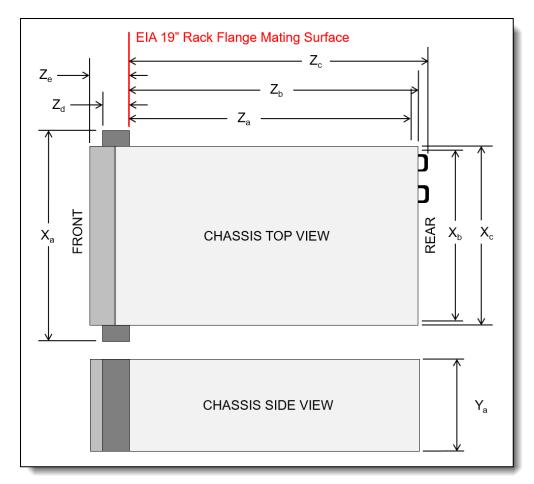


Figure 16. Server dimensions

The shipping dimensions (cardboard packaging) of the SR860 V2 are as follows:

- Width: 610 mm (24.0 inches)
- Height: 557 mm (21.9 inches)Depth: 1016 mm (40.0 inches)

The server has the following weight:

Minimum configuration: 32 kg (71 lb)
Maximum configuration: 62 kg (137 lb)

The server has the following electrical specifications:

- · Input voltage:
 - 100 to 127 (nominal) Vac, 50 Hz or 60 Hz
 - 200 to 240 (nominal) Vac, 50 Hz or 60 Hz
 - 180 to 300 Vdc (China only)
- Inlet current:
 - 100-127 V:
 - 750W Platinum power supply: 8.7 A
 - 750W Titanium power supply: Not supported
 - 1100W power supply: 12.1 A*
 - 1800W power supply: Not supported
 - o 200-240 V:
 - 750W Platinum power supply: 3.8 A
 - 750W Titanium power supply: 3.8 A
 - 1100W power supply: 5.6 A
 - 1800W power supply: 9.3 A

Operating environment

ThinkSystem SR860 V2 complies with ASHRAE Class A2 specifications. Depending on the hardware configuration, some models comply with ASHRAE Class A3 and Class A4 specifications. System performance may be impacted when operating temperature is outside ASHRAE A2 specification.

Temperature and humidity

The server is supported in the following environment:

- Air temperature:
 - Operating
 - ASHRAE Class A2: 10°C to 35°C (50°F to 95°F); the maximum ambient temperature decreases by 1°C for every 300 m (984 ft) increase in altitude above 900 m (2,953 ft).
 - ASHRAE Class A3: 5°C to 40°C (41°F to 104°F); the maximum ambient temperature decreases by 1°C for every 175 m (574 ft) increase in altitude above 900 m (2,953 ft).
 - ASHRAE Class A4: 5°C to 45°C (41°F to 113°F); the maximum ambient temperature decreases by 1°C for every 125 m (410 ft) increase in altitude above 900 m (2,953 ft).
 - Server off: 5°C to 45°C (41°F to 113°F)
 - Shipment/storage: -40°C to 60°C (-40°F to 140°F)
- Maximum altitude: 3,050 m (10,000 ft)
- Relative Humidity (non-condensing):
 - Operating
 - ASHRAE Class A2: 8% to 80%; maximum dew point: 21°C (70°F)
 - ASHRAE Class A3: 8% to 85%; maximum dew point: 24°C (75°F)
 - ASHRAE Class A4: 8% to 90%; maximum dew point: 24°C (75°F)
 - Shipment/storage: 8% to 90%

Ambient temperature requirements

Adjust ambient temperature when specific components are installed:

- Keep ambient temperature to 35°C or lower when one or more of the following components are installed.
 - Processors with TDP value greater than 165W and less than/equal 205W (165W < TDP ≤

^{*} In China, this power supply cannot exceed 10 A current.

205W)

- DRAM DIMMs with capacity larger than 64 GB
- Keep ambient temperature to 35°C or lower when all of the following components are installed together.
 - Processors with TDP value 205W ≤ TDP ≤ 250W
 - 24 or more drives
- Keep room temperature to 30°C or lower when one or more of the following components are installed.
 - Processors with TDP value 205W or greater (TDP ≥ 205W)
 - Any GPU
 - Persistent memory: To avoid triggering throttle, it is advised that the ambient temperature is kept 27°C or lower when persistent memory modules are installed.

Acoustic noise emissions

The server has the following acoustic noise emissions declaration:

- Sound power level (L_{WAd})
 - o Idling: Typical config: 6.1 Bel, Storage config: 6.8 Bel, GPU config: 7.4 Bel
 - Operating: Typical config: 7.0 Bel, Storage config: 7.5 Bel, GPU config: 8.2 Bel
- Sound pressure level (L pAm):
 - Idling: Typical config: 47 dBA, Storage config: 53 dBA, GPU config: 60 dBA
 - Operating: Typical config: 55 dBA, Storage config: 61 dBA, GPU config: 67 dBA

Notes:

- These sound levels were measured in controlled acoustical environments according to procedures specified by ISO7779 and are reported in accordance with ISO 9296.
- The declared acoustic sound levels are based on the specified configurations, which may change slightly depending on configuration/conditions.
 - Typical configuration: 4x 165W processors, 24x 64 GB DIMMs, 24x SAS drives, RAID 930-8i adapter, Intel X710 10Gb 2-port Ethernet adapter, 4x 1100W power supplies
 - Storage configuration: 4x 205W processors, 48x 64 GB DIMMs, 48x SAS drives, RAID 940-16i adapter, Intel X710 10Gb 2-port Ethernet adapter, 4x 1100W power supplies
 - GPU configuration: 4x 205W processors, 48x 64 GB DIMMs, 48x SAS drives, RAID 940-16i adapter, Intel X710 10Gb 2-port Ethernet adapter, 8x NVIDIA Tesla T4 GPUs, 4x 1800W power supplies
- Government regulations (such as those prescribed by OSHA or European Community Directives) may govern noise level exposure in the workplace and may apply to you and your server installation. The actual sound pressure levels in your installation depend upon a variety of factors, including the number of racks in the installation; the size, materials, and configuration of the room; the noise levels from other equipment; the room ambient temperature, and employee's location in relation to the equipment. Further, compliance with such government regulations depends on a variety of additional factors, including the duration of employees' exposure and whether employees wear hearing protection. Lenovo recommends that you consult with qualified experts in this field to determine whether you are in compliance with the applicable regulations.

Vibration and shock

The server has the following vibration and shock limits:

- Vibration:
 - Operating: 0.21 G rms at 5 Hz to 500 Hz for 15 minutes across 3 axes
 - Non-operating: 1.04 G rms at 2 Hz to 200 Hz for 15 minutes across 6 surfaces
- Shock:
 - Operating: 15 G for 3 milliseconds in each direction (positive and negative X, Y, and Z axes)
 - · Non-operating:
 - 23 kg 31 kg: 35 G for 152 in./sec velocity change across 6 surfaces
 - 32 kg 68 kg: 35 G for 136 in./sec velocity change across 6 surfaces

Particulate contamination

Airborne particulates (including metal flakes or particles) and reactive gases acting alone or in combination with other environmental factors such as humidity or temperature might damage the system that might cause the system to malfunction or stop working altogether. The following specifications indicate the limits of particulates that the system can tolerate:

- · Reactive gases:
 - The reactivity rate of copper coupons shall be less than 200 Angstroms per month (Å/month)
 - The reactivity rate of silver coupons shall be less than 200 Å/month
- Airborne particulates:
 - The room air should be continuously filtered with MERV 8 filters.
 - Air entering a data center should be filtered with MERV 11 or preferably MERV 13 filters.
 - The deliquescent relative humidity of the particulate contamination should be more than 60% RH
 - · Data centers must be free of zinc whiskers

For additional information, see the Specifications section of the Setup Guide for the server, available from the Lenovo ThinkSystem Information Center, https://thinksystem.lenovofiles.com/help/index.jsp

Warranty and Support

The SR860 V2 has a 1-year or 3-year warranty based on the machine type of the system:

- 7Z59 1-year warranty
- 7Z60 3-year warranty
- 7D42 SAP HANA configurations with 3-year warranty

The standard warranty terms are customer-replaceable unit (CRU) and onsite (for field-replaceable units FRUs only) with standard call center support during normal business hours and 9x5 Next Business Day Parts Delivered.

Lenovo's additional support services provide a sophisticated, unified support structure for your data center, with an experience consistently ranked number one in customer satisfaction worldwide. Available offerings include:

• Premier Support

Premier Support provides a Lenovo-owned customer experience and delivers direct access to technicians skilled in hardware, software, and advanced troubleshooting, in addition to the following:

- o Direct technician-to-technician access through a dedicated phone line
- 24x7x365 remote support
- · Single point of contact service
- · End to end case management
- Third-party collaborative software support
- Online case tools and live chat support
- · On-demand remote system analysis

Warranty Upgrade (Preconfigured Support)

Services are available to meet the on-site response time targets that match the criticality of your systems.

- o 3, 4, or 5 years of service coverage
- 1-year or 2-year post-warranty extensions
- **Foundation Service**: 9x5 service coverage with next business day onsite response. YourDrive YourData is an optional extra (see below).
- **Essential Service:** 24x7 service coverage with 4-hour onsite response or 24-hour committed repair (available only in select countries). Bundled with YourDrive YourData.
- **Advanced Service**: 24x7 service coverage with 2-hour onsite response or 6-hour committed repair (available only in select countries). Bundled with YourDrive YourData.

Managed Services

Lenovo Managed Services provides continuous 24x7 remote monitoring (plus 24x7 call center availability) and proactive management of your data center using state-of-the-art tools, systems, and practices by a team of highly skilled and experienced Lenovo services professionals.

Quarterly reviews check error logs, verify firmware & OS device driver levels, and software as needed. We'll also maintain records of latest patches, critical updates, and firmware levels, to ensure you systems are providing business value through optimized performance.

• Technical Account Management (TAM)

A Lenovo Technical Account Manager helps you optimize the operation of your data center based on a deep understanding of your business. You gain direct access to your Lenovo TAM, who serves as your single point of contact to expedite service requests, provide status updates, and furnish reports to track incidents over time. In addition, your TAM will help proactively make service recommendations and manage your service relationship with Lenovo to make certain your needs are met.

• Enterprise Server Software Support

Enterprise Software Support is an additional support service providing customers with software support on Microsoft, Red Hat, SUSE, and VMware applications and systems. Around the clock availability for critical problems plus unlimited calls and incidents helps customers address challenges fast, without incremental costs. Support staff can answer troubleshooting and diagnostic questions, address product comparability and interoperability issues, isolate causes of problems, report defects to software vendors, and more.

YourDrive YourData

Lenovo's YourDrive YourData is a multi-drive retention offering that ensures your data is always under your control, regardless of the number of drives that are installed in your Lenovo server. In the unlikely event of a drive failure, you retain possession of your drive while Lenovo replaces the failed drive part. Your data stays safely on your premises, in your hands. The YourDrive YourData service can be purchased in convenient bundles and is optional with Foundation Service. It is bundled with Essential Service and Advanced Service.

Health Check

Having a trusted partner who can perform regular and detailed health checks is central to maintaining efficiency and ensuring that your systems and business are always running at their best. Health Check supports Lenovo-branded server, storage, and networking devices, as well as select Lenovo-supported products from other vendors that are sold by Lenovo or a Lenovo-Authorized Reseller.

Examples of region-specific warranty terms are second or longer business day parts delivery or parts-only base warranty.

If warranty terms and conditions include onsite labor for repair or replacement of parts, Lenovo will dispatch a service technician to the customer site to perform the replacement. Onsite labor under base warranty is limited to labor for replacement of parts that have been determined to be field-replaceable units (FRUs). Parts that are determined to be customer-replaceable units (CRUs) do not include onsite labor under base warranty.

If warranty terms include parts-only base warranty, Lenovo is responsible for delivering only replacement parts that are under base warranty (including FRUs) that will be sent to a requested location for self-service. Parts-only service does not include a service technician being dispatched onsite. Parts must be changed at customer's own cost and labor and defective parts must be returned following the instructions supplied with the spare parts.

Lenovo Service offerings are region-specific. Not all preconfigured support and upgrade options are available in every region. For information about Lenovo service upgrade offerings that are available in your region, refer to the following resources:

- Service part numbers in Lenovo Data Center Solution Configurator (DCSC): http://dcsc.lenovo.com/#/services
- Lenovo Services Availability Locator http://lenovolocator.com/

For service definitions, region-specific details, and service limitations, please refer to the following documents:

- Lenovo Statement of Limited Warranty for Infrastructure Solutions Group (ISG) Servers and System Storage
 - http://pcsupport.lenovo.com/us/en/solutions/ht503310
- Lenovo Data Center Services Agreement http://support.lenovo.com/us/en/solutions/ht116628

Services

Lenovo Services is a dedicated partner to your success. Our goal is to reduce your capital outlays, mitigate your IT risks, and accelerate your time to productivity.

Note: Some service options may not be available in all countries. For more information, go to https://www.lenovo.com/services. For information about Lenovo service upgrade offerings that are available in your region, contact your local Lenovo sales representative or business partner.

Here's a more in-depth look at what we can do for you:

• Asset Recovery Services

Asset Recovery Services (ARS) helps customers recover the maximum value from their end-of-life equipment in a cost-effective and secure way. On top of simplifying the transition from old to new equipment, ARS mitigates environmental and data security risks associated with data center equipment disposal. Lenovo ARS is a cash-back solution for equipment based on its remaining market value, yielding maximum value from aging assets and lowering total cost of ownership for your customers. For more information, see the ARS page, https://lenovopress.com/lp1266-reduce-e-waste-and-grow-your-bottom-line-with-lenovo-ars.

Assessment Services

An Assessment helps solve your IT challenges through an onsite, multi-day session with a Lenovo technology expert. We perform a tools-based assessment which provides a comprehensive and thorough review of a company's environment and technology systems. In addition to the technology based functional requirements, the consultant also discusses and records the non-functional business requirements, challenges, and constraints. Assessments help organizations like yours, no matter how large or small, get a better return on your IT investment and overcome challenges in the ever-changing technology landscape.

• Design Services

Professional Services consultants perform infrastructure design and implementation planning to support your strategy. The high-level architectures provided by the assessment service are turned into low level designs and wiring diagrams, which are reviewed and approved prior to implementation. The implementation plan will demonstrate an outcome-based proposal to provide business capabilities through infrastructure with a risk-mitigated project plan.

Basic Hardware Installation

Lenovo experts can seamlessly manage the physical installation of your server, storage, or networking hardware. Working at a time convenient for you (business hours or off shift), the technician will unpack and inspect the systems on your site, install options, mount in a rack cabinet, connect to power and network, check and update firmware to the latest levels, verify operation, and dispose of the packaging, allowing your team to focus on other priorities.

• Deployment Services

When investing in new IT infrastructures, you need to ensure your business will see quick time to value with little to no disruption. Lenovo deployments are designed by development and engineering teams who know our Products & Solutions better than anyone else, and our technicians own the process from delivery to completion. Lenovo will conduct remote preparation and planning, configure & integrate systems, validate systems, verify and update appliance firmware, train on administrative tasks, and provide post-deployment documentation. Customer's IT teams leverage our skills to enable IT staff to transform with higher level roles and tasks.

• Integration, Migration, and Expansion Services

Move existing physical & virtual workloads easily, or determine technical requirements to support increased workloads while maximizing performance. Includes tuning, validation, and documenting ongoing run processes. Leverage migration assessment planning documents to perform necessary migrations.

Regulatory compliance

The SR860 V2 server conforms to the following standards:

- Energy Star 3.0
- FCC: Verified to comply with Part 15 of the FCC Rules, Class A
- Canada ICES-003, issue 6, Class A
- UL/IEC 62368-1
- CAN/CSA-C22.2 No. 62368-1
- NOM-019
- Argentina IEC 62368-1
- Japan VCCI, Class A
- Australia/New Zealand AS/NZS CISPR 32, Class A; AS/NZS 60950.1; AS/NZS 62368.1:2014
- IEC 60950-1 & IEC 62368-1 (CB Certificate and CB Test Report)
- China CCC (GB4943.1), GB9254 Class A, GB17625.1
- Taiwan BSMI CNS13438, Class A: CNS14336-1; section 5 of CNS15663
- Korea KN32, Class A; KN35
- Russia, Belorussia and Kazakhstan, EAC: TP TC 004/2011 (for Safety); TP TC 020/2011 (for EMC); TP EAC 037/2016 (for RoHS)
- CE Mark (EN55032 Class A, EN60950-1, EN62368-1, EN55024, EN55035, EN61000-3-2, (EU) 2019/424, EN 50581-1 and EN61000-3-3)
- CISPR 32, Class A
- GS (EN62368-1, EK1-ITB2000, AfPS GS 01 PAK Par. 3.1)
- India BIS certification

External drive enclosures

The server supports attachment to external drive enclosures using a RAID controller with external ports or a SAS host bus adapter. Adapters supported by the server are listed in the SAS adapters for external storage section.

Note: Information provided in this section is for ordering reference purposes only. For the operating system and adapter support details, refer to the interoperability matrix for a particular storage enclosure that can be found on the Lenovo Data Center Support web site:

http://datacentersupport.lenovo.com

Table 55. External drive enclosures

	Part number		
Description	Worldwide	Japan	PRC
Lenovo Storage D1212 LFF Disk Expansion with Dual SAS IO Modules	4587A11	4587A1J	4587A1C
Lenovo Storage D1224 SFF Disk Expansion with Dual SAS IO Modules	4587A31	4587A3J	4587A3C
Lenovo Storage D3284 4TB x 84 HD Expansion Enclosure	641311F		
Lenovo Storage D3284 6TB x 84 HD Expansion Enclosure	641312F		
Lenovo Storage D3284 8TB x 84 HD Expansion Enclosure	641313F		
Lenovo Storage D3284 10TB x 84 HD Expansion Enclosure	641314F		

For details about supported drives, adapters, and cables, see the following Lenovo Press Product Guides:

- Lenovo Storage D1212 and D1224 http://lenovopress.com/lp0512
- Lenovo Storage D3284 http://lenovopress.com/lp0513

External storage systems

Lenovo offers the ThinkSystem DE Series and ThinkSystem DM Series external storage systems for highperformance storage. See the DE Series and DM Series product guides for specific controller models, expansion enclosures and configuration options:

- ThinkSystem DE Series Storage https://lenovopress.com/storage/thinksystem/de-series#rt=product-guide
- ThinkSystem DM Series Storage https://lenovopress.com/storage/thinksystem/dm-series#rt=product-guide

External backup units

The server supports both USB-attached RDX backup units and SAS-attached tape drives.

The following table lists the available external SAS tape backup options.

Tip: Verify the end-to-end support of an IBM tape backup solution through the IBM System Storage Interoperation Center (SSIC): http://www.ibm.com/systems/support/storage/ssic

Table 56. External SAS backup options

Part number	Description	
External SA	AS tape backup drives	
6160S6E	IBM TS2260 Tape Drive Model H6S	
6160S7E	IBM TS2270 Tape Drive Model H7S	
6160S8E	IBM TS2280 Tape Drive Model H8S	
External SA	AS tape backup autoloaders	
6171S6R	IBM TS2900 Tape Autoloader w/LTO6 HH SAS	
6171S7R	IBM TS2900 Tape Autoloader w/LTO7 HH SAS	
6171S8R	IBM TS2900 Tape Autoloader w/LTO8 HH SAS	
External ta	External tape backup libraries	
6741A1F	IBM TS4300 3U Tape Library-Base Unit	
SAS backu	SAS backup drives for TS4300 Tape Library	
01KP934	LTO 6 HH SAS Drive	
01KP937	LTO 7 HH SAS Drive	
01KP953	LTO 8 HH SAS Drive	

For more information, see the list of Product Guides in the Backup units category: https://lenovopress.com/servers/options/backup

The following table lists the external RDX backup options available.

Table 57. External RDX dock and cartridges

Part number	Feature code	Description	
External RDX	External RDX docks		
4T27A10725	B32R	ThinkSystem RDX External USB 3.0 Dock (No cartridge included with the drive)	
Cartridges	Cartridges		
7TP7A01601	AVF8	ThinkSystem RDX 500GB Cartridge	
7TP7A01602	AVF1	ThinkSystem RDX 1TB Cartridge	
7TP7A01603	AVF0	ThinkSystem RDX 2TB Cartridge	
7TP7A04318	AXD1	ThinkSystem RDX 4TB Cartridge	

For more information, see the Lenovo RDX USB 3.0 Disk Backup Solution product guide: https://lenovopress.com/tips0894-rdx-usb-30

Fibre Channel SAN switches

Lenovo offers the ThinkSystem DB Series of Fibre Channel SAN switches for high-performance storage expansion. See the DB Series product guides for models and configuration options:

 ThinkSystem DB Series SAN Switches: https://lenovopress.com/storage/switches/rack#rt=product-guide

Uninterruptible power supply units

The following table lists the uninterruptible power supply (UPS) units that are offered by Lenovo.

Table 58. Uninterruptible power supply units

Part number	Description
55941AX	RT1.5kVA 2U Rack or Tower UPS (100-125VAC)
55941KX	RT1.5kVA 2U Rack or Tower UPS (200-240VAC)
55942AX	RT2.2kVA 2U Rack or Tower UPS (100-125VAC)
55942KX	RT2.2kVA 2U Rack or Tower UPS (200-240VAC)
55943AX	RT3kVA 2U Rack or Tower UPS (100-125VAC)
55943KX	RT3kVA 2U Rack or Tower UPS (200-240VAC)
55945KX	RT5kVA 3U Rack or Tower UPS (200-240VAC)
55946KX	RT6kVA 3U Rack or Tower UPS (200-240VAC)
55948KX	RT8kVA 6U Rack or Tower UPS (200-240VAC)
55949KX	RT11kVA 6U Rack or Tower UPS (200-240VAC)
55948PX	RT8kVA 6U 3:1 Phase Rack or Tower UPS (380-415VAC)
55949PX	RT11kVA 6U 3:1 Phase Rack or Tower UPS (380-415VAC)
55943KT†	ThinkSystem RT3kVA 2U Standard UPS (200-230VAC) (2x C13 10A, 2x GB 10A, 1x C19 16A outlets)
55943LT†	ThinkSystem RT3kVA 2U Long Backup UPS (200-230VAC) (2x C13 10A, 2x GB 10A, 1x C19 16A outlets)
55946KT†	ThinkSystem RT6kVA 5U UPS (200-230VAC) (2x C13 10A outlets, 1x Terminal Block output)
5594XKT†	ThinkSystem RT10kVA 5U UPS (200-230VAC) (2x C13 10A outlets, 1x Terminal Block output)

[†] Only available in China and countries in the Asia Pacific region.

For more information, see the list of Product Guides in the UPS category:

https://lenovopress.com/servers/options/ups

Power distribution units

The following table lists the power distribution units (PDUs) that are offered by Lenovo.

Table 59. Power distribution units

Part number	Description
0U Basic PDU	s
00YJ776	0U 36 C13/6 C19 24A/200-240V 1 Phase PDU with NEMA L6-30P line cord
00YJ777	0U 36 C13/6 C19 32A/200-240V 1 Phase PDU with IEC60309 332P6 line cord
00YJ778	0U 21 C13/12 C19 32A/200-240V/346-415V 3 Phase PDU with IEC60309 532P6 line cord
00YJ779	0U 21 C13/12 C19 48A/200-240V 3 Phase PDU with IEC60309 460P9 line cord
Switched and	Monitored PDUs
00YJ780	0U 20 C13/4 C19 Switched and Monitored 32A/200-240V/1Ph PDU w/ IEC60309 332P6 line cord
00YJ781	0U 20 C13/4 C19 Switched and Monitored 24A/200-240V/1Ph PDU w/ NEMA L6-30P line cord
00YJ782	0U 18 C13/6 C19 Switched / Monitored 32A/200-240V/346-415V/3Ph PDU w/ IEC60309 532P6 cord
00YJ783	0U 12 C13/12 C19 Switched and Monitored 48A/200-240V/3Ph PDU w/ IEC60309 460P9 line cord
46M4003	1U 9 C19/3 C13 Switched and Monitored 60A 3 Phase PDU with IEC 309 3P+Gnd line cord
46M4004	1U 12 C13 Switched and Monitored DPI PDU (without line cord)
46M4005	1U 12 C13 Switched and Monitored 60A 3 Phase PDU with IEC 309 3P+Gnd line cord
Ultra Density E	Enterprise PDUs (9x IEC 320 C13 + 3x IEC 320 C19 outlets)
71762NX	Ultra Density Enterprise C19/C13 PDU Module (without line cord)
71763NU	Ultra Density Enterprise C19/C13 PDU 60A/208V/3ph with IEC 309 3P+Gnd line cord
C13 Enterprise	e PDUs (12x IEC 320 C13 outlets)
39M2816	DPI C13 Enterprise PDU+ (without line cord)
39Y8941	DPI Single Phase C13 Enterprise PDU (without line cord)
C19 Enterprise	e PDUs (6x IEC 320 C19 outlets)
39Y8948	DPI Single Phase C19 Enterprise PDU (without line cord)
39Y8923	DPI 60A 3 Phase C19 Enterprise PDU with IEC 309 3P+G (208 V) fixed line cord
Front-end PDI	Js (3x IEC 320 C19 outlets)
39Y8938	DPI 30amp/125V Front-end PDU with NEMA L5-30P line cord
39Y8939	DPI 30amp/250V Front-end PDU with NEMA L6-30P line cord
39Y8934	DPI 32amp/250V Front-end PDU with IEC 309 2P+Gnd line cord
39Y8940	DPI 60amp/250V Front-end PDU with IEC 309 2P+Gnd line cord
39Y8935	DPI 63amp/250V Front-end PDU with IEC 309 2P+Gnd line cord
NEMA PDUs (6x NEMA 5-15R outlets)
39Y8905	DPI 100-127V PDU with Fixed NEMA L5-15P line cord
Line cords for	PDUs that ship without a line cord
40K9611	DPI 32a Line Cord (IEC 309 3P+N+G)
40K9612	DPI 32a Line Cord (IEC 309 P+N+G)
40K9613	DPI 63a Cord (IEC 309 P+N+G)
40K9614	DPI 30a Line Cord (NEMA L6-30P)
40K9615	DPI 60a Cord (IEC 309 2P+G)
40K9617	DPI Australian/NZ 3112 Line Cord

Part number	Description	
40K9618	DPI Korean 8305 Line Cord	

For more information, see the Lenovo Press documents in the PDU category: https://lenovopress.com/servers/options/pdu

Rack cabinets

The following table lists the supported rack cabinets.

Table 60. Rack cabinets

Part number	Description
93072RX	25U Standard Rack
93072PX	25U Static S2 Standard Rack
93634PX	42U 1100mm Dynamic Rack
93634EX	42U 1100mm Dynamic Expansion Rack
93604PX	42U 1200mm Deep Dynamic Rack
93614PX	42U 1200mm Deep Static Rack
93084EX	42U Enterprise Expansion Rack
93084PX	42U Enterprise Rack
93074RX	42U Standard Rack

For specifications about these racks, see the Lenovo Rack Cabinet Reference, available from: https://lenovopress.com/lp1287-lenovo-rack-cabinet-reference

For more information, see the list of Product Guides in the Rack cabinets category: https://lenovopress.com/servers/options/racks

KVM console options

The following table lists the supported KVM consoles.

Table 61. KVM console

Part number	Description
4XF7A73009	ThinkSystem 18.5" LCD Console (with English keyboard)

The following table lists the available KVM switches and the options that are supported with them.

Table 63. KVM switches and options

Part number	Description		
KVM Console sv	KVM Console switches		
1754D1T	ThinkSystem Digital 2x1x16 KVM Switch (DVI video output port)		
1754A1T	ThinkSystem Analog 1x8 KVM Switch (DVI video output port)		
1754D2X	Global 4x2x32 Console Manager (GCM32)		
1754D1X	Global 2x2x16 Console Manager (GCM16)		
1754A2X	Local 2x16 Console Manager (LCM16)		
1754A1X	Local 1x8 Console Manager (LCM8)		
Cables for Think	System Digital and Analog KVM Console switches		
4X97A11108	ThinkSystem VGA to DVI Conversion Cable		
4X97A11109	ThinkSystem Single-USB Conversion Cable for Digital KVM		
4X97A11107	ThinkSystem Dual-USB Conversion Cable for Digital KVM		
4X97A11106	ThinkSystem USB Conversion Cable for Analog KVM		
Cables for GCM and LCM Console switches			
46M5383	Virtual Media Conversion Option Gen2 (VCO2)		
46M5382	Serial Conversion Option (SCO)		

For more information, see the list of Product Guides in the KVM Switches and Consoles category: http://lenovopress.com/servers/options/kvm

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Related publications and links

For more information, see these resources:

- Lenovo ThinkSystem SR860 V2 product page: https://www.lenovo.com/us/en/data-center/servers/mission-critical/ThinkSystem-SR860-V2-Server/p/77XX7HS86V2
- Interactive 3D Tour of the ThinkSystem SR860 V2: https://lenovopress.com/LP1304
- ThinkSystem SR860 V2 drivers and support http://datacentersupport.lenovo.com/products/servers/thinksystem/sr860-v2/7z60/downloads
- Lenovo Hardware Installation & Removal Videos on the SR860 V2:
 - YouTube: https://www.youtube.com/playlist?list=PLYV5R7hVcs-C6QgmsUMRG6ul0bHzrGmsG
 - Youku: http://list.youku.com/albumlist/show/id_54461099.html
- Lenovo ThinkSystem SR860 V2 product publications:

http://thinksystem.lenovofiles.com/help/index.isp

- Quick Start
- · Rack Installation Guide
- Setup Guide
- Hardware Maintenance Manual
- Messages and Codes Reference
- Memory Population Reference
- ServerProven hardware compatibility:

http://www.lenovo.com/us/en/serverproven

Related product families

Product families related to this document are the following:

- ThinkSystem SR860 V2 Server
- 4-Socket Rack Servers

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